656406

AUSTRALIA PATENTS ACT 1990 NOTICE OF ENTITLEMENT

We, Valente, Inc., the applicant/Nominated Person in respect of Application No. 22611/92 state the following:-

The Nominated Person is entited to the grant of the patent because the Nominated Person derives title to the invention from the inventors by assignment.

The Nominated Person is entitled to claim priority from the application listed in the declaration under Article 8 of the PCT because the Nominated Person is the assignee of the applicants in respect of the application listed in the declaration under Article 8 of the PCT, and because that application was the first application made in a Convention country in respect of the invention.

DATED this NINETEENTH day of JANUARY 1994

a member of the firm of DAVIES COLLISON CAVE for and on behalf of the applicant(s)

(DCC ref: 1638752)

AU9222611

(12) PATENT ABRIDGMENT (11) Document No. AU-B-22611/92 (19) AUSTRALIAN PATENT OFFICE (10) Acceptance No. 656406

(54)Title METHOD AND SYSTEM FOR DESIGNING A CUTTING TOOL

International Patent Classification(s) (51)⁵ G05B 019/405

B23B 027/22

(21) Application No.: 22611/92 (22) Application Date: 12.06.92

- PCT Publication Number: WO93/01537 (87)
- (30)Priority Data
- (31) Number 724305
- (32)Date 01.07.91
- (33) Country

US UNITED STATES OF AMERICA

- Publication Date: 11.02.93 (43)
- Publication Date of Accepted Application: 02.02.95
- (71)Applicant(s) VALENITE, INC.
- (72) Inventor(s) STEVEN F WAYNE; DAVID A O'NEIL; CHARLES E ZIMMERMAN; YEFIM VAL
- (74)Attorney or Agent DAVIES COLLISON CAVE, 1 Little Collins Street, MELBOURNE VIC 3000
- (57)
- 1. A method of designing a cutting tool comprising the steps of:
- providing a modifiable finite element tool model for predicting tool response during a cutting operation on a workpiece, wherein said tool model includes a tool input vector with at least one adjustable tool parameter;
- (b) providing a modifiable finite element chip-flow model for simulating chip-flow during said cutting operation, wherein said chip-flow model includes a chip-flow input vector with at least one adjustable chip-flow parameter;
 - executing said tool model to derive the prediction of said tool response; (c)
- (d) executing said chip-flow model to derive the simulation of said chip-flow;
- (e) evaluating said predicted tool response and said simulated chip-flow with an artificial intelligence means including an adaptive set of rules for determining a correlation between said predicted tool response and said simulated chip-flow and acceptability criterion;
- **(f)** providing recommendations with said artificial intelligence means based on said correlation:
- altering at least one of said modifiable tool parameters, said modifiable chip-flow parameters, and said adaptive rules with said artificial intelligence means based on said recommendations; and

(11) AU-B-22611/92

-2-

(10) 656406

(h) repeating steps (a) through (g) until an acceptable correlation corresponding to an optimal tool design is achieved.

OPI DATE 11/02/93 APPLN. ID 22611/92 ADJP DATE 08/04/93 PCT NUMBER PCT/US92/05172



.....Y (PCT)

(51) International Patent Classification 5:

G05B 19/405

(11) International Publication Number:

WO 93/01537

A1

(43) International Publication Date:

NL, SE).

21 January 1993 (21.01.93)

(21) International Application Number:

PCT/US92/05172

(22) International Filing Date:

12 June 1992 (12.06.92)

(30) Priority data:

(74) Agent: LOHMANN, Victor, F., III; GTE Service Corporation, 40 Sylvan Road MS#31, Waltham, MA 02254

(AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LU, MC,

724,305

1 July 1991 (01.07.91)

(81) Designated States: AU, BR, CA, JP, KR, European patent US

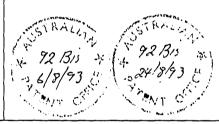
VALENITE INC.

(71) Applicant: GTE VALENITE CORPORATION [US/US]; 1209 Orange-Street, Wilmington, DE 19801 (US):

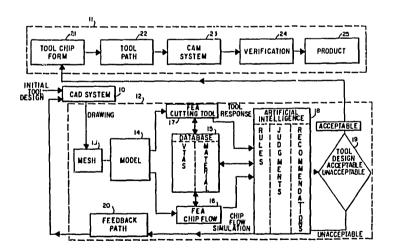
750 Stephenson Highway Troy MI 48007 (US).
750 Stephenson Highway Troy MI 48007 (US).
(72) Inventors: WAYNE, Steven, F.; 73 Pratt Road, Scituate, MA 02066 (US). O'NEIL, David, A.; #1, 26 Rich Street, Waltham, MA 02154 (US). ZIMMERMAN, Charles, E. 9320 Autumnglo Drive, Clarkston, MI 48348 (US). VAL, Yefim; 2872 Somerset, Apartment 108, Troy, MI 48084 (US).

Published

With international search report.



(54) Title: METHOD AND SYSTEM FOR DESIGNING A CUTTING TOOL



(57) Abstract

A method of designing a cutting tool uses finite element numerical models (14) to predict a response of the tool during a simulated cutting operation on a workpiece, and to simulate a chip-flow phenomenon occurring during the cutting operation. The chip-flow model (14) incorporates representations of a fracture mechanism describing a chip separation phenomenon, a heat-generating mechanism describing a thermal coupling phenomenon, and a shear localization mechanism describing a shearing phenomenon wherein these phenomena occur during the cutting operation. The predicted tool response and the chip-flow simulation are evaluated by an artificial intelligence system (18) to render rule-based judgments which are embodied in recommendations for continuously modifying the models (14) and input design variables until the simulation and response converge to an optimal result.

METHOD AND SYSTEM FOR DESIGNING A CUTTING TOOL

The present invention is directed to cutting tools and, more particularly, to a method for designing a 5 cutting tool by evaluating predicted tool response and chip-flow simulations of simulated cutting operations.

The design of cutting tools, and their utilization in machining materials under various cutting conditions, 10 has traditionally relied upon a combination of experience and empirical data. Disadvantageously, this approach is very time consuming, costly, and difficult to apply. With the introduction of new cutting tool materials such as ceramics and cermets, there exisits in the prior art 15 an even greater demand for chip control, tool reliability and high performance in view of the complex cutting conditions under which these new tools are subjected.

In conventional product design cycles, the cuttingtool design engineer usually begins the design of a new
20 tool with a specific product objective such as: (i)
requirement to cut a specific material, or (ii) utilization of a particular cutting speed, feed or depth of cut
in a lathe, mill, or other cutting machine. Based on
previous tool design experience, the designer selects the
25 tool material which usually consists of a hard substrate
such as WC-Co with suitable coatings applied to the
surface for further protection against tool wear.

The chipbreaker geometry of the cutting tool surface is specified based on tool material and machining 30 conditions, and a prototype tool is constructed in accordance with this geometry and the design specifications. Conventional machinability tests for evaluating the performance of the tool typically consist of applying the prototype tool insert to the specified 35 workpiece material over a range of machining conditions such as cutting speed, depth of cut, and feed rate. As

the tool insert is applied to the workpiece, chips are formed with characteristics particular to each cutting These chips are preferably used to construct condition. a chip-board matrix depicting the chip geometries as a 5 function of range of speeds and feeds for a selected workpiece material. The chip board is then used to determine the optimal range of cutting conditions for the newly designed insert based upon chip morphology, chip microstructure, machine dynamic response (such as 10 chatter, noise, and power consumption), and wear characteristics of the cutting tool. A desired chip geometry results when the excess workpiece material is cut into small, discrete fragments curled substantially in the shape of the numeral '6'. Long or 'stringy' chips are 15 considered unacceptable since they reduce the performance of unmanned machining centers and produce a safety hazard to machine-tool operators.

Disadvantageously, the prototypical tool design procedure of the prior art typically does not meet its 20 desired performance objectives in the first several iterations of this design and testing process, thereby causing the designer to repeat the procedure until a suitable level of performance is attained. This is a time-consuming process, further delayed by the difficulty 25 in manufacturing new prototype tool inserts. For example, prototype cutting tools based on the WC-Co material mentioned above are manufactured by powder metallurgy methods but require a complex and expensive punch-and-die set for cold pressing the powders.

30 Furthermore, redesign or rework in the tool design or manufacturing operations lead to further delays and lead-time in the development of new products.

Another aspect of tool development in the prior art is the unavailability of results from previous 35 machinability studies for use in evaluating tool response. For example, a characteristic of the cutting

tool industry is that information accumulated by individual tool designers based on their experience with diverse machining operations is typically not made available to the tool industry since the industry lacks a mechanism for collecting and disseminating such information. Consequently, there exists in the industry a need to consolidate the prior information gained in machinability tests, and to integrate this data into a system whereby tool design experience can be stored and 10 easily accessed in a computerized data base.

While the cutting tool industry has historically designed new tools by repeatedly manufacturing and testing tool prototypes as discussed above, the prior art has recently used mathematical models of the 15 metal-cutting process to predict the shear plane angle, outgoing chip thickness, and forces exerted on the tool insert. Examples of such predictive models are discussed by E.M. Trent in Metal Cutting, Butterworths, 1984; M.C. Shaw in Metal Cutting Principles, MIT Press, 1968; and by 20 N.N. Zorev in Metal Cutting Mechanics, Pergamon Press, 1966. Most of these models incorporate elastic-plastic material model, but with no temperature or rate effects included. Good agreement with experimental results can be achieved with these models 25 for the shear plane angle related to the rake angle and chip thickness. However, these models fail to adequately describe the process in that they do not account for friction along the tool-chip interface, strain hardening of the workpiece, temperature and rate-dependent 30 properties of the workpiece, and the mechanics of separation of the chip from the workpiece. modifications to these models are disclosed by Boothroyd, et al. in "Effects of Strain Rate and Temperature in orthogonal metal cutting, " J. of Mechanical Eng. Science, 351966 and Stevenson, et al.

As a further modification, Strenkowski and Carroll in "A finite element model of orthogonal metal cutting," ASME Journal of Engineering for Industry (1985) and Usui in "Progress of predictive theories in metal cutting," 5 JSME International Journal (1988) discuss finite element models of the cutting process. The simulations with these models occur under orthogonal cutting conditions so that plane theories of deformation can be applied, and require machinability data as input (such as chip-shape 10 and flow lines). However, these models are only applicable at very low cutting speeds. Additionally, Benton, et al. in "An adiabatic heating finite element analysis of metal cutting, "MIT (1986), Iwata, et al. in "Process modeling of orthogonal cutting by the 15 rigid-plastic finite element method," ASME J. of Engineering Materials and Technology (1984), Strenkowski, supra, illustrate the separation of the chip from the workpiece by a release of certain nodes in the finite element mesh as the chip slides across the surface 20 of the tool. Lee, et al. in "Material modeling and high-speed machining processes," Advanced Machining Research Program Annual Report, General Electric Co., Schenectady, NY (1982) illustrate the separation by the 'death' of certain elements by removing them from 25 following iterations of the solution procedure. Analyses using rigid-plastic material properties for the chip at low cutting speeds under isothermal conditions were also performed as disclosed in Iwata, et al., supra and Lee, et al., supra. Iwata's model included a fracture 30 prediction of the chip from the workpiece, based on the ductile fracture strain of the steel under consideration. Strenkowski, supra, and Strenkowski and Mitchum in

Strenkowski, <u>supra</u>, and Strenkowski and Mitchum in "An improved finite element model of orthogonal metal cutting," Manufacturing Technology Review-NAMRC XV (1987) 35 illustrate an updated Lagrangian approach for the investigation of the cutting process. The material model of

the workpiece was thermo-elasto-plastic with friction at the interface of the tool and chip. A parting-line criterion was used for the separation of the chip from the workpiece, and a critical strain measure was implemented to determine when the chip would separate. Large volumes of the workpiece and tool were modeled in this approach, thus resulting in prohibitively large computation times.

Benton, et al., <u>supra</u>, abandoned the concept of a strain-to-failure at the debonding of the chip from the workpiece in favor of a release criterion based on the distance of the workpiece from the tip of the cutting tool.

10

15

25

In summary, the prior art in the design and selection of cutting tools has lacked an integrated system for readily accessing machining data and tool design experience from a database, for comprehensive and accurate modeling of the physical phenomena in cutting operations, and for adaptively evaluating tool response and chip-flow simulations.

Accordingly, the present invention provides a method of designing a cutting tool comprising the steps of:

- (a) providing a modifiable finite element tool model for predicting tool
 response during a cutting operation on a workpiece, wherein said tool model includes a tool input vector with at least one adjustable tool parameter;
 - (b) providing a modifiable finite element chip-flow model for simulating chip-flow during said cutting operation, wherein said chip-flow model includes a chip-flow input vector with at least one adjustable chip-flow parameter;
 - (c) executing said tool model to derive the prediction of said tool response;
 - (d) executing said chip-flow model to derive the simulation of said chip-flow;
 - (e) evaluating said predicted tool response and said simulated chip-flow with an artificial intelligence means including an adaptive set of rules for determining a correlation between said predicted tool response and said simulated chip-flow and acceptability criterion;
 - (f) providing recommendations with said artificial intelligence means based



941116,p:\oper\gcp,22611.92,5

on said correlation;

10

15

20

25

- (g) altering at least one of said modifiable tool parameters, said modifiable chip-flow parameters, and said adaptive rules with said artificial intelligence means based on said recommendations; and
- 5 (h) repeating steps (a) through (g) until an acceptable correlation corresponding to an optimal tool design is achieved.

The invention also provides a system for designing a cutting tool comprising:
tool response model means for predicting tool response and including an input
tool vector with at least one modifiable tool parameter;

chip-flow model means for predicting chip-flow and including a chip-flow input vector with at least one modifiable chip-flow parameter;

first executing means for executing said tool response model means to derive the prediction of said tool response;

second executing means for executing said chip-flow model means to derive the simulation of said chip-flow;

artificial intelligence means for evaluating said predicted tool response and said simulated chip-flow and for determining a correlation between said predicted tool response and said simulated chip-flow and acceptability criterion using an adaptive set of rules, wherein said artificial intelligence means includes means for providing recommendations based on said correlation and means for altering at least one of said modifiable tool parameters, said modifiable chip-flow parameters, and said adaptive set of rules based on said recommendation; and

decision means for identifying an acceptable correlation corresponding to an optimum tool design and for repeating said prediction, said simulation, and said correlation with said recommendations if said acceptable correlation is not achieved.



evaluating said simulations with an adaptive judgment base in a dynamic learning environment; integrating said simulations and evaluation into said learning environment; and continuously modifying said input parameters in accordance with said evaluation until an acceptable evaluation is achieved.

In the drawings:

FIGURE 1 shows a block diagram of a cutting tool 10 system in accordance with the present invention;

FIGURES 2A-2C are flow diagrams illustrating the function of module 12 in Figure 1;

FIGURE 3A shows a schematic of a metal cutting operation simulated by the present invention;

15 FIGURE 3B shows a mesh geometry of the tool nose in Figure 3A;

FIGURE 4 shows an exemplary von Mises stress distribution in the tool nose of Figure 3A;

FIGURES 5A and 5B graphically depict a parameter 20 study based on the response shown in Figure 4;

FIGURE 6 shows a debonding finite element in accordance with the present invention;

FIGURE 7A illustrates a four-noded bond element utilized in the present invention;

25 FIGURE 7B illustrates a stress iso-surface in accordance with a first debond element of the present invention;

FIGURE 7C illustrates a stress iso-surface in accordance with a second debond element of the present 30 invention;

FIGURE 8 is a stress-strain curve for the debonding element of Figure 7A;

FIGURE 9 is a photograph of a cross-section of the chip-forming process showing shear-localized zones;



FIGURES 10A AND 10B show the finite element mesh geometries used in models simulating non-localized and localized phenomenon, respectively;

FIGURE 11A illustrates a finite element tool mesh in 5 accordance with the present invention;

FIGURE 11B shows the 2-D FEA stress results from a thermally coupled simultaneous analysis of a cutting tool and metal chip with interface friction;

FIGURE 11C shows geometric modeling of the cutting 10 surface of a tool;

FIGURE 12A is a side view of an undeformed chip;
FIGURE 12B is a three-dimensional view of a deformed chip in accordance with the chip-flow simulation of the present invention;

15 FIGURE 13 is a temperature distribution of the chip in Figure 12B;

FIGURE 14 is an amplified view of the chip shown in Figure 12A, illustrating clearly the location of the cutting tool and lower surface debonding elements;

20 FIGURE 15 is a further perspective view of the cutting operation in Figure 12B;

FIGURE 16 is a perspective view of a deformed chip in accordance with a simulation of the present invention;

FIGURE 17 illustrates a series of von Mises stress 25 contours for a deformed chip;

FIGURE 18 shows an overview of the database system used in the present invention;

FIGURE 19 is a flow diagram used to evaluate a tool design;

30 Figures 20 and 21 are schematics of chipbreaker geometries analyzed by the present invention; and

Figures 22 and 23 are chipflow simulations from cutting operations using the tools of Figures 20 and 21, respectively.

The method for designing a cutting tool in accordance with the present invention is implemented by the system shown in block diagram format in Figure 1. The system includes a CAD (Computer Aided Design) module 10, a manufacturing module 11, and an analysis module 12 for receiving a tool design, predicting the performance of the tool design in simulated cutting operations, and manufacturing a prototype tool based on an optimal tool design from module 12. The following sections detail the 10 functions and operations performed by each module in Figure 1, and illustrate the information flow among the integrated modules.

I. Simulation and Modeling

- The analysis module 12 includes a mesh module 13 for creating a finite element mesh of a cutting tool geometry, a model generator 14 for providing mathematical models based on the mesh geometries, a database 15 including a materials database and a tool cutting
- 20 database, a Finite Element Analysis (FEA) Chip-Flow module 16 for performing a finite element analysis of the chip formation process, an FEA Cutting Tool Module 17 for performing a finite element analysis of the cutting tool response, and an artificial intelligence (AI) module 18
- 25 for (i) evaluating the results from modules 16 and 17 by applying the simulation and response results to a rule-based comparison hierarchy and by rendering judgments based on the comparisons, and (ii) proposing a recommendation for a new tool design embodying
- 30 modifications to the models and input parameters. A decision module 19 reviews the recommendation and awards control of the system to either feedback module 20 for further analysis based on the evaluation, or to manufacturing module 11 to construct a prototype tool 35 when the tool design is acceptable.

Figures 2A-2C are flowcharts illustrating the steps executed by the system in Figure 1 for optimally designing a tool in accordance with the present invention. In particular, the flowcharts define the cooperative interaction between the database 15, the AI module 18, chip-flow module 16, and tool module 17 in the system block diagram of Figure 1. Each of the decision blocks and function statements appearing in Figures 2A-2C will be described below in greater detail, and will be 10 identified by a parenthesized step letter.

The particular analysis pursued by the designer is chosen from among four options: chip, tool, chip and tool, and three-dimensional (3D). The first three analyses are two-dimensional and are represented by the 15 flowchart in Figure 2A, while the three-dimensional analysis is executed by the steps in Figure 2B. The steps in Figure 2C are common to all of the analyses.

A. Tool Response

When it is desired to predict only the tool response during a simulated cutting operation, the flowchart in Figure 2A executes along branch 30-1. Initially, a tool geometry is selected with a corresponding set of tool properties such as stress, strain, and creep. (Steps a 25 and b).

The simulated cutting operation according to the present invention is illustrated in the diagrammatic representation of Figure 3A, and is defined by the movement of a workpiece 32 along the contact surface of a 30 chamferred tool nose 31 (with the selected chipbreaker geometry) of a stationary tool insert 33 held by a steel tool holder 34. A chip 35 is formed by removal of material from the workpiece 32, a physical process which will hereinafter be referred to as a chip-flow 35 phenomenon.

Figure 3B is an enlarged view of the tool nose portion 31 encircled in Figure 3A which represents a mesh geometry based on the selected tool design. (Step \underline{c}).

- Module 17 primarily utilizes linear finite element 5 models of the cutting tool nose to investigate the response of the tool nose to cutting loads, and in particular has been employed in the design of new inserts, the test and failure analysis of cutting tools, and the evaluation of edge preparation methods.
- 10 Non-linear responses such as creep (discussed <u>infra</u>) are also possible in module 17. With respect to the analyses of particular tool materials, tool behavior is linear for ceramics, while non-linearities are frequently present in the tool response of carbides and coated cutting tools.
- The tool model is based on the mesh geometry of Figure 3B, and is constructed from commercially available linear finite element software packages such as the software tools GIFTS and ANSYS. (Step d). These software packages, however, may provide limited non-linear
- 20 capabilities, and are executable on personal computer workstations, thereby facilitating analysis in laboratories. It should be obvious to those skilled in the art that other suitable linear FEA packages can be used, as well as other hardware systems for executing the 25 code.

Force vectors representing tool loading due to the cutting action are indicated by the arrows along the edge of nose 31 in Figure 3B. These approximate loads are applied as input parameters to the finite element model 30 of the cutting tool, and the response of the tool is then calculated by executing the source code from which the tool model is constructed. (Step <u>f</u>). One such response is the predicted von Mises stress distribution throughout the tool of Figure 3B, which is shown in Figure 4 as a 35 series of stress contours each with a stress value

alphabetically indexed to corresponding von Mises criteria in the accompanying legend.

Figure 5A reveals the results of a parameter study wherein chamfer angle served as an input parameter to the tool model. The study continually modified chamfer angle in a series of tool simulations to estimate tool response, and plotted tensile stress as a function of chamfer angles to illustrate their interdependence. Based on this study, subsequent tool life was then 10 predicted as shown in the bar graph of Figure 5B. Employing numerically predictive mathematical models to predict the range of tool responses allows a number of tool designs to be tested and analyzed without manufacturing a single physical tool, hence reducing the 15 number of tool prototypes that have to be manufactured.

The above discussion concerned the steps executed for predicting tool response. The remaining steps for displaying results, interpreting/evaluating the results, and modifying the models and tool designs are explained 20 below in sections III and IV with reference to the flowchart of Figure 2C.

When it is desired to include characteristics of the chip-flow phenomenon as variables for consideration in the optimal design of a cutting tool, the flowchart of 25 Figure 2A executes along branch 30-2. The software package ABAQUS available from Hibbitt, Karlsson, and Sorenson, Inc. (HKS) of Providence, Rhode Island, is utilized to implement the models, particularly the chip-flow model. It will be readily appreciated by those 30 skilled in the art that the description and requirements of the chip-flow model as set forth below are sufficient to enable one skilled in the art with access to ABAQUS to write the software code representing the models.

The models discussed hereinafter in accordance with 35 the present invention were developed using the ABAQUS Theory and Users Manuals, Version 4.8, copyright 1989

(incorporated herein by reference) available from HKS.

ABAQUS is a batch program which assembles a data deck containing model data and history data. Model data define a finite element model with elements, nodes, element properties, material definitions, and any other data that specify the particulars of the model. History data define what happens to the model, and includes the sequence of events or loadings for which the model's response is sought. In ABAQUS this history is divided by 10 the user into a sequence of steps each including a procedure type such as statis stress analysis or transient heat transfer analysis.

A finite element model consists of a geometric description defined by the elements and their nodes, and 15 a set of properties associated with the elements describing their attributes such as material definitions and parameters for interface elements. There may also be constraints in the model represented by linear or nonlinear equations involving several of the fundamental 20 solution variables in the model, and relating to simple boundary conditions that are to be imposed at the start of the analysis.

The element library in ABAQUS supports a geometric modeling capability wherein the elements use numerical 25 integration to allow complete generality in material behavior. Shell and beam element properties may be defined as general section behaviors, or each cross-section of the element may be integrated numerically, so that nonlinear response can be tracked 30 accurately if desired.

The geometric models according to the present invention utilize various finite elements of ABAQUS to simulate certain physical phenomenon, particularly the chip formation process. For modeling the chip-flow 35 phenomenon, the stress-displacement element CPE4 is used when thermal coupling is not represented, while the

WO 93/01537 PCT/US92/05172

coupled temperature/displacement element CPE4T is used when a thermal coupling process is included in the model.

The tool response is modeled by an element (rigid surface interface element IRS21) which does not

5 experience defomation, and by two slide line interface elements ISL21 and ISL21T which allow for tool deformation during the cutting operation. Element ISL21T is used when a thermal coupling analysis is desired. Stree-displacement element B21 is used to model workpiece 10 rotation, while a user-defined element U1 implements both debonding finite elements (discussed infra) in a user subroutine UEL.

The purpose of a finite element analysis is to predict the response of a model to some form of external 15 loading, or to some non-equilibrium intiial conditions. ABAQUS makes available a series of procedures for facilitating modeling of the particular history to be analyzed. The ABAQUS history procedures used by the present invention include *COUPLED TEMPERATURE
20 DISPLACEMENT for performing a fully coupled simultaneous heat transfer and stress analysis, *DYNAMIC EXPLICIT for performing dynamic stress/displacement analysis using direct integration, and *STATIC for performing a

The above finite elements and response analyses should not serve a a limitation of the present invention, as it should be apparent to those skilled in the art that other elements and procedures may be used to implement the tool and chip-flow simulations of the present invention.

non-thermal coupling static stress/displacement analysis.

B. Chip-Flow Simulation

Module 16 in Figure 1 simulates the aforementioned chip-flow phenomenon which is physically represented by

the curling of a metal chip 35 away from a workpiece 32 as shown in Figure 3A. The chip-flow phenomenon is a non-liner physical process that is not as easily modelled as the tool response.

- The chip-flow phenomenon in metal cutting describes the mechanics of material removal from the original workpiece during cutting operations. This phenomenon inherently involves the formation of new surfaces, large deformations associated with the creation of chips, and the internal generation of heat. Possible sources of such heat generation are sliding contact along the tool surface and permanent deformation of the chip, although other sources should be well known to those skilled in the art. Accordingly, numerical models of the chip-
- 15 forming process must accurately account for these physical processes in order to render accurate predictions of stress, strain, temperature and other performance measures. Application of the finite element method to large deformation problems in solid mechanics
- 20 has been documented by Y.J. Bathe in Finite Element Procedures in Engineering Analysis, Prentice-Hall (1982), and by O.C. Zienkiewicz in the Finite Element Method, McGraw-Hill (1982).

There are two principal objectives for modelling the 25 chip-flow process: (1) calculating the loads and temperatures under steady-state conditions on the surfaces of the cutting tool to support cutting tool design, and (2) numerically predicting the chip morphology and quantifying the stress and strain state to assess the 30 performance of a given cutting tool material and geometry on a specific workpiece material.

In practice, the tool is used in a lathe or milling machine at various speeds and depths of cut.

Observations of the cutting process during machinability 35 tests, as well as evaluation of the chips that are created, permit the tool design engineer to describe the

cutting conditions under which a tool best performs.

Satisfaction of these two objectives will provide data for creep and wear predictions of cutting tool inserts under operating conditions, and greatly reduce the time and cost needed in the production of improved new cutting tools.

The following sections describe several physical mechanisms which exist in the chip-flow phenomenon and which are represented in the chip-flow model of the 10 present invention.

With respect to the flowchart of Figure 2A, both the chip and chip/tool analyses require the selection of workpiece properties including stress, strain, and temperature values. (Step g). This exemplary list of properties should not serve as a limitation of the present invention, but rather as a representative set of the workpiece properties well known to those skilled in the art and selectable by step g.

One novel aspect of the present invention is that

20 the chip-flow model incorporates a representation of a
fracture mechanism describing a chip separation
phenomenon known as debonding. The chip fracture
mechanism defines a release of said chip from the
workpiece and is represented by a debonding finite

25 element in the chip-flow model. Consequently,
determining the appropriate debonding properties is part
of the selection of workpiece materials in step g. The
following discussion is a detailed explanation of the
debonding mechanism and its finite element representation

30 in the chip-flow model.

Debonding

The finite element model embodied in module 16 includes a fracture-mechanics based debonding criterion 35 for separation of the chip from the workpiece, and time-

WO 93/01537 PCT/US92/05172

dependent and temperature-dependent material properties. As will be discussed hereinbelow, the model allows for the use of an explicit time integration scheme for the equations of motion to permit numerical modeling of the metal cutting chip flow problem in three dimensions.

More specifically, two debonding elements have been created to model the separation of the chip from the workpiece. Both models are fracture-mechanics based finite elements, and allow time and temperature dependent 10 material properties. The first debonding element has a circular stress iso-surface as shown in Figure 7B, while the second element has a concave-down iso-surface as shown in Figure 7C. Both elements may be used in metal cutting simulations where no compression exists along the 15 chip-workpiece interface (such as in positive rake cutting). The element with the concave-down iso-furface is compression-insensitive and may be used for simulations where any stress state exists along the 20 chip-workpiece interface.

First Debonding Finite Element (compression-dependent)

The method by which the separation (or debonding) of the chip from the workpiece is modeled plays an important 25 role in the morphology and response of the resultant chip, and temperatures and loads applied to the cutting tool.

In three-dimensional metal cutting, the chip separates, or debonds, from the workpiece material on two 30 planes: one normal to the feed direction, and one normal to the depth-of-cut (DOC) direction. This separation and creation of new surface was modeled by developing a fracture mechanics-based debonding finite element 61 which is located between the chip and the workpiece as 35 shown in Figure 6.

The debond element provides a mechanism to gradually release the chip from the workpiece material, and also

provides a nearly rigid bond for low bond strains. a specified bond strain occurs in the neighborhood of the debonding element, the element begins to fracture. Fracture here is used in the continuous damage sense, that is the stresses decrease for increasing bond strain until zero stress is reached. It remains zero thereafter; no damage recovery (material healing) is The amount of energy dissipated by damaging is assumed to be equal to the energy required to propagate a 10 crack across the length of the element. This energy then serves to heat the chip and workpiece material in thermally coupled models. The value of this fracture energy is determined from critical J-integral values for the workpiece material.

This element 61 debonds when a critical fracture strain is reached, which is based on the J-integral value for the workpiece material. The special element has a damaged elasticity nature with a gradual reduction in stress-carrying capabilities as the normalized damage to the material progresses from zero to one. A detailed explanation of the first debond element follows below.

The element itself consists of four nodes, as shown in Figure 7A. The element really only provides a bond between nodes A and B. The material properties of the 25 workpiece material only have influence over the bond between nodes A and B, while nodes C and D are used only to provide an 'area' for stress calculations. The spokes illustrated in Figure 7A model the workpiece material. Previous models of the chip-flow process have not included such detailed material property-based fracture of the chip from the workpiece.

This 'area' for stress computations is calculated from (length * depth), where

length= $(1-\alpha)$ * distance(B,C) + α * distance(B,D) (8)

and, for plane strain, unit depth is assumed. The length is based on the original geometry.

The forces transmitted by the element are simply the stresses multiplied by length, where the stresses are computed from the strains. The strain values include DirectStrain= $(V_B^-V_A^-)$ /thick and ShearStrain= $(U_B^-U_A^-)$ /thick where U_B^- , U_A^- , V_B^- , and V_A^- represent displacements in the x-direction for node B, the x-direction for node A, the y-direction for node B, and the y-direction for node A, 10 respectively.

Since the orientation of the element is fixed, the forces transmitted between nodes A and B are not truly direct so that shear forces normal to the chip surface at node A are not parallel to the Y-axis. In the models of the present invention, the center of the spokes and the tool tip both lie on the Y-axis. Advantageously, the radius of curvature of the unseparated chip is large so that the approximation errors in the debonding calculations are very small. The purpose of the element 20 is to provide automatic debonding as determined by the cutting process and material properties.

The bond material is based on a damaged J₂ plasticity theory. The damage manifests itself in two forms - a degradation of the yield stress with damage and 25 a damaged elasticity. Figure 8 illustrates the stress/strain behavior of the material model. The material behaves as an elastic material until the equivalent strain reaches a value of e_{yd}. If the strain continues to increase monotonically, the damage will 30 increase from zero when the strain equals e_{yd} to a value of one when the strain reaches the failure strain of e_f. The equivalent strain is monitored continuously and the maximum value attained is tracked. The maximum value, e_{max}, equals the maximum over all time of e_f. The 35 equivalent strain is calculated as

$$e_{eq} = (3/2 e_{ij} e_{ij})^{\frac{1}{2}},$$
 (1)

where e_{ij} is the deviatoric part of the total strain ϵ_{ij} . The material unloads along a damaged elasticity, as shown in Figure 8.

The damage is calculated from the equivalent strain 5 as

$$D = ({^{e}_{max} - e_{yd}})/(e_{f} - e_{yd})$$
 (2)

Note that the value of e_{max} must be initialized to e_{vd} in the following algorithm.

The value for e_{yd} is given by the initial undamaged 10 yield stress, σ_0 , divided by 2μ . The value for e_f is derived from fracture mechanics principles. The energy required to create a crack of length ℓ and width w is given by $J_{IC}^{*\ell w}$. The strain energy density in the material is given by the area under the stress strain 15 curve (1/2 $\sigma_0 e_f$) in Figure 8. The work performed creating new fracture surface must equal the strain energy dissipated

$$J_{TC}^{*\ell w} = 1/2\sigma_{O}^{e} e_{f}^{\ell wt}, \qquad (3)$$

where t is the thickness of the element. Solving 20 Equation (3) for e_f gives

$$e_f = 2J_{IC}/\sigma_0 t \tag{4}$$

The yield stress of the material continually degrades as the damage grows:

25
$$\sigma_{yd}(D) = (1-D)\sigma_0$$
 (5)

The material's elastic response is based on a damaged elasticity. The damaged elastic moduli are given by:

$$2\mu_{\rm D} = (1-D)2\mu \ (e_{\rm max}/e_{\rm vd})$$
 (6)

$$K_{D} = (1-D)K \left(e_{\text{max}} / e_{\text{vd}} \right)$$
 (7)

30 where $2\mu_{\rm D}$ and $K_{\rm D}$ are the damaged shear modulus and bulk modulus, respectively.

The debonding of the material is assumed to

Second Debonding Finite Element (compression-independent)

This element has one node on the chip and three nodes on the base. The bond is established between the node on the chip and the center node on the base. The 5 other two nodes on the base are used to calculate the effective area associated with the element. The thickness of the debonding element h is determined by the user, and is usually some relatively small fraction of the chip thickness. The geometry of the element is shown 10 in Figure 7A.

The user must also specify the material properties of the debonding element. The initial Young's modulus E_{O} is usually selected equal to the modulus of the chip material. Poisson's ratio is assumed to be 0.5. The 15 maximum failure stress σ_{max} is selected equal to, or, for

- maximum failure stress σ_{max} is selected equal to, or, for softening materials, smaller than the initial yield stress of the chip material. The critical energy release rate for full debonding J_{C} is usually chosen equal to the critical energy release rate for crack propagation.
- 20 Since debonding mainly occurs by shearing the material, the best choice is probably the release rate for mode II crack propagation.

The thickness of the debonding element is used to obtain the debonding strains. The direct strain is

$$\epsilon = \Delta v/h,$$

where Δv is the relative displacement of the chip normal to the cutting surface and the shear strain is

$$rac{1}{2} = \Delta u/h$$

where Δv is the relative displacement of the chip tangen-30 tial to the cutting surface. For small values of the strains, the direct stress σ and the shear stress χ in the debonding material will be obtained with the elastic moduli:

$$\sigma = E_0 \varepsilon$$
, $\tau = G_0 \varepsilon = 1/3E_0 \varepsilon$.

35 From the direct and the shear stress, we compute an equivalent stress with the equations

$$\overline{\sigma} = (\sigma^2 + 3\tau^2)^{1/2} \text{ if } \sigma > 0$$

$$\overline{\sigma} = (3)^{1/2} |\tau| \text{ if } \sigma \le 0.$$

Note that the first expression corresponds to the von Mises stress. Similarly, we define the equivalent strain

$$\overline{\varepsilon} = (\varepsilon^2 + (1/3)\tau^2)^{1/2} \text{ if } \varepsilon > 0$$

$$\overline{\varepsilon} = (3)^{1/2} |\tau| \quad \text{if } \varepsilon \leq 0.$$

An equivalent stress iso-surface is shown in Figure 7C.

Once the equivalent stress (strain) exceeds a critical value σ_{max} (ϵ_{max}) the material of the debonding 10 element is assumed to be damaged. The elastic modulus diminishes with increasing equivalent strain, such that the equivalent stress decreases linearly with the equivalent strain. The stress becomes zero once the equivalent strain reaches the value

15 $\epsilon_{\text{soft}} = 2J_{\text{c}}/(\sigma_{\text{max}}t)$

Hence, we can define a softening modulus

$$E_{\text{soft}} = -\sigma_{\text{max}}/\epsilon_{\text{soft}}$$

which is the effective modulus for continued loading, that is further damaging of the material. The

20 stress-strain law is shown in Figure 8. The amount of material damage at any given point in time is given by the damage parameter D which varies from 0 (no damage) to 1 (complete debonding). Hence, D follows from

D = 0 if
$$\overline{\epsilon} \le \epsilon_{\text{max}}$$

D = $(\overline{\epsilon} - \epsilon_{\text{max}})/\epsilon_{\text{soft}}$ if $\epsilon_{\text{max}} < \overline{\epsilon} < \epsilon_{\text{max}} + \epsilon_{\text{soft}}$
D = 1 if $\overline{\epsilon} \ge \epsilon_{\text{max}} + \epsilon_{\text{soft}}$

For a partially damaged material, the damage parameter defines a critical damage stress

$$\sigma_{\text{dam}} = (1-D)\sigma_{\text{max}} = (1-(\overline{\epsilon}-\epsilon_{\text{max}})/\epsilon_{\text{soft}}) \sigma_{\text{max}} = (\overline{\epsilon}-\epsilon_{\text{max}}-\epsilon_{\text{soft}})^{E}_{\text{soft}}$$

and an effective damaged modulus

30

 $E_{\rm dam}^{=\overline{\sigma}/\overline{\epsilon}} = (1 - (\epsilon_{\rm max}^{+}\epsilon_{\rm soft}^{-})/\overline{\epsilon}) E_{\rm soft}$ The direct and shear stresses follow from

$$\sigma = E_{\text{dam}} \epsilon, \quad \tau = G_{\text{dam}} \quad \dot{\tau} = 1/3 \quad E_{\text{dam}} \quad \text{if } \sigma > 0$$

$$\sigma = E_{0} \epsilon, \quad \tau = G_{\text{dam}} \quad \dot{\tau} = 1/3 \quad E_{\text{dam}} \quad \text{if } \sigma \leq 0.$$

If, after damaging, the equivalent strain decreases we assume that no further damage occurs and hence the material behaves elastic with Young's modulus E_{dam} (or E_{o} in compression) and shear modulus G_{dam} . 5 equivalent strain increases the damaged modulus changes. For $\sigma > 0$ this yields.

$$d\sigma = E_{dam} d\epsilon + dE_{dam} \epsilon$$

$$d\tau = 1/3 (E_{dam} d\tau) dE_{dam} \tau$$

and for $\sigma \leq 0$

10 $d\sigma = E_d\epsilon$ $d\tau = 1/3(E_{dam}dt + dE_{dam}t).$

From the previously derived expression for E_{dam} follows

 $dE_{dam} = [(\epsilon_{max} + \epsilon_{soft})/\overline{\epsilon}^{2}] E_{soft} d\overline{\epsilon}.$ For behavior in tension ($\sigma > 0$) thus follows

 $dE_{dam} = [(\epsilon_{max} + \epsilon_{soft})/\overline{\epsilon}^{3}] E_{soft}(\epsilon d\epsilon + 1/3 i di)$ 15 and for behavior in compression

 $dE_{dam} = 1/3 [(\epsilon_{max} + \epsilon_{soft})/\overline{\epsilon}^3] E_{soft} E_{soft}$ It is convenient to define the normalized strains

$$n_{\varepsilon} = \varepsilon/\overline{\varepsilon}, \quad n_{\chi} = (1/3)\sqrt{\varepsilon}.$$

20 It is also convenient to observe that

 $[(\epsilon_{\text{max}} + \epsilon_{\text{soft}})/\overline{\epsilon}] E_{\text{soft}} = E_{\text{soft}} - E_{\text{dam}}.$ After some manipulation this yields for the rate of change if stress in tension

 $d\sigma = E_{dam} d\epsilon + (E_{soft} - E_{dam}) [n_{\epsilon} n_{\epsilon} d\epsilon + n_{\epsilon} n_{\gamma} d\tau]$ $d\tau = G_{dam}dt + (E_{soft} - E_{dam})[n_t n_{\epsilon} d\epsilon + n_{\epsilon} n_t dt]$ and in compression, since $n_r = 0$ and $n_\chi = 1/\sqrt{3}$ $d\sigma = E_{o}d\epsilon$

 $d\tau = G_{dam}dt + 1/3(E_{soft} - E_{dam})dt = 1/3E_{soft}dt$.

30

The debonding process outlined above for both debonding elements is modelled with a simple elastic predictor radial return algorithm. The state variables are the total deviatoric strains, the damage, and the 35 maximum equivalent strain. As is well known to those skilled in the art, the superscripts above variables

5

indicate integration. The constitutive calculations proceed as follows:

Calculate the damaged elasticity constants:

$$2\mu_{D} = (1-D^{n})2\mu e_{\text{max}}^{n}/e_{\text{yd}}$$

$$K_{D} = (1-D^{n})Ke_{\text{max}}^{n}/e_{\text{yd}}$$

Calculate deviatoric and volumetric parts of the strain rate:

Integrate the deviatoric strains: 10

$$e_{ij}^{n+1} = e_{ij}^{n} + \Delta t \dot{e}_{ij}$$

Calculate the new maximum equivalent strain:

$$e_{eq}^{n+1} = [3/2 \ e_{ij}^{n+1} \ e_{ij}^{n+1}]^{\frac{1}{2}}$$

 $e_{max}^{n+1} = max(e_{eq}^{n+1}, e_{max}^{n})$ Calculate trial stress: 15

$$\mathbf{P}^{\mathsf{tr}} = \mathbf{P}^{\mathsf{n}} + \Delta \mathsf{t} \mathsf{K}_{\mathsf{D}} \mathbf{\varepsilon} \\
\mathbf{S}^{\mathsf{tr}} = \mathbf{S}^{\mathsf{n}} = \mathbf{S}^{\mathsf{n}} + \Delta \mathsf{t} 2\mu_{\mathsf{D}} \mathbf{\varepsilon}_{\mathsf{i}\mathsf{j}}$$

Calculate the new damage value

$$D^{n+1} = \max(1, (e_{\max}^{n+1} - e_{yd})/(e_{\underline{f}} - e_{yd}))$$

Calculate von Mises equivalent trial stress and radial return factor:

$$\sigma = [3/2 \text{ str str}_{ij}]^{\frac{1}{2}}$$
 $f_r = \min(1, (1-D)\sigma_0/\sigma)$

Perform radial return on the trial stresses: 25

$$P^{n+1} = f_r \cdot P^{tr}$$

 $S_{ij}^{n+1} = f_r \cdot S_{ij}^{tr}$

The debond element formulation is best described in two-dimensional form because of its simplicity.

30 should be obvious to those skilled in the art that the above-described debond algorithm is implementable in Fortran source code which can be used with the ABAQUS input deck of the chip-flow model to execute the chip-flow simulation.

20

Thermal Coupling

Another novel aspect of the chip-flow model of the present invention is that it incorporates a representation of a heat-generating mechanism describing a thermal coupling phenomenon. As indicated by step \underline{h} , the chip and chip/tool simulations further include the selection of chip/tool interface properties such as friction coefficients, thermal properties, and interface geometries.

The work involved in machining the workpiece and in 10 causing the material removal process contributes to the generation of heat. This heat is substantially generated by three coupled and concurrently operating mechanisms: permanent deformation of the chip material, fracture of 15 the chip from the workpiece, and the sliding of the chip with friction along a contact face of the cutting tool. It is important to consider this heat generation in the cutting process because the material properties of the workpiece and tool material have temperature dependent 20 properties. This temperature dependency leads to the characterization of the heat generation as a thermally coupled phenomenon since the heat generated by the mechanisms in the cutting process (which depend on tool and workpiece properties) alter the properties of the 25 workpiece and tool, which in turn affect the cutting process.

To properly include this thermal coupling phenomenon, the chip-flow model of the present invention incorporates representations of the following phenomenon and material characteristics: the temperature dependent properties of the materials, heat and its subsequent transfer across the chip-tool interface, and fracture energy created by the debonding of the chip from the workpiece.

In particular, the permanent deformation is modeled by representing in the chip-flow model that a fraction of

heat generated by said deformation is introduced into said deforming chip. The fracture is modeled by representing in the chip-flow model that a fraction of heat liberated by said debonding element upon release from said workpiece is introduced into said chip. Finally, the chip sliding is modeled by representing in the chip-flow model that a selected fraction of heat which is generated by said sliding is introduced into said chip while the remaining fraction is introduced into 10 said tool.

As illustrated in Figure 2A, the selection of chip/tool interface properties is followed by the selection of a tool and chipbreaker geometry, and also the selection of tool properties as in step <u>a</u> if a 15 chip/tool simulation is desired. (Steps <u>h-l</u>). Based on the chosen geometries, the algorithms of the present invention generate tool and chip meshes from which mathematically predictive models of the tool response and chip-flow process are constructed. (Steps <u>m-o</u>). 20 However, before proceeding with the simulations, the user has the option of incorporating a localization mechanism

Localization/Chip Breakage

into the chip-flow model. (Step p).

As introduced above, another novel aspect of the chip-flow model of the present invention is that it incorporates a representation of a shear localization mechanism describing a shearing phenomenon.

Shear localization occurs during the cutting process 30 when the shear strain of the workpiece material concentrates in a narrow band, effectively creating a shear strain discontinuity in the region of the band. Figure 9 illustrates the size of this zone 91 for specific cutting conditions on AISI4340 steel. These zones give the chip 35 a serrated inner surface, and are a precursor to chip

WO 93/01537 PCT/US92/05172

-26-

breakage because of the weakened zone and stress concentration at the root of the serrations.

In order to mathematically reconstruct the 'chip-board' from machinability studies, the model should 5 predict the onset of chip breakage to correctly estimate the size of the chips. Inclusion of the localization process in the chip flow model is therefore a necessity. Accordingly, the chip-flow model of the present invention incorporates this physical process by using thermally 10 coupled material properties, and by including special finite elements which permit discontinuities in the strain field.

Most shear localization in metal cutting is due to thermally-induced negative stress-strain characteristics 15 of the material; thus, thermally coupled analyses will permit this phenomenon to occur. In fact, since most metals strain-harden at a given temperature without the thermal coupling, shear localization is impossible. When the localization process begins, the elements in the 20 primary shear zone undergo very large strains over short lengths (relative to element size). By using many elements whose sides and diagonals are approximately along the direction of localization as in Figure 10B, the present invention has included this phenomenon in the Figure 10A is shown for comparison purposes to illustrate how an inappropriate choice of finite elements will not permit the localization mechanism to be manifested during the chip formation process.

If the relative size of the shear band becomes very small, current element technology in cutting simulations cannot account for the magnitude of the strain jump at the band. However, it would be obvious to those skilled in the art that the present invention, and specifically the localization mechanism, includes other special finite slements which incorporate displacement (and strain) discontinuities in their deformation field. Should these

elements prove useful, they will be included in the chip-flow model.

In summary, the shear localization mechanism represents a shear strain discontinuity in a region of 5 said workpiece and is represented by shear discontinuity finite elements in said chip-flow model. The localization mechanism is incorporated into the chip-flow model by selecting said shear discontinuity finite elements so as to properly describe said shear 10 localization mechanism, discretizing said discontinuity elements, and modifying material property-related parameters in said chip-flow model to be temperature-dependent. (Step g).

As presented hereinabove, the chip-flow model
15 incorporates representations of a fracture mechanism
describing a chip separation phenomenon, a
heat-generating mechanism describing a thermal coupling
phenomenon, and a shear localization mechanism describing
a shearing phenomenon wherein these phenomena occur
20 during the cutting operation.

The Appendix to the specification is an ABAQUS instruction set for performing a chip-flow analysis using the chipbreaker geometries in Figures 20 (design #1) and 21 (design #2). The results of the analyses for the 25 geometries in Figures 20 and 21 are indicated in the chip-flow illustrations of Figures 22 and 23, respectively. As shown, the primary shear zone 23-1 of design #2 is larger than the zone 22-1 of design #1, indicating that design #2 has the better chip control 30 because the chip is more affected by the chipbreaker geometry.

C. Chip and Tool Studies

In connection with the discussions above concerning 35 the phenomenon represented in the chip-flow model of the present invention, the acquisition of the boundary

WO 93/01537 PCT/US92/05172

conditions on the tool due to the action of the cutting process is a primary consideration of any chip-flow model. By describing such boundary conditions, wear and creep studies based on the simulations can then outline the performance of the cutting tool. Conventional models, however, have considered the tool as a rigid surface which plows through the workpiece material or, at most, considered only the elastic deformation of the cutting tool.

0IAdvantageously, the chip-flow models of the present invention incorporate the strain, rate, and temperature dependent properties of the tool by way of the thermal coupling phenomenon (step h), while simultaneously performing the cutting analysis. Figure 11A shows an 15 example of a cutting tool finite element mesh according to the present invention (steps m and n) with high element density at the tool/chip interface. temperatures and loads from the chip flowing by the cutting tool are transferred to the tool via interface 20 elements, resulting in the two-dimensional nonlinear finite element stress results [Pa-von Mises stress] in Figure 11B computed from a thermally-coupled simultaneous analysis of the cutting tool and metal chip with interface friction.

The creep characteristics of the cutting tool are such that, in comparison to the rate of flow of the workpiece material over the tool, no creep of the tool will be seen over the time period of any chip flow simulation. By suitable modification of the time base of the cutting tool properties, deformation of the tool can be observed by simulating the cutting process for a sustained cut.

In addition to simultaneous simulation of the chipand-tool, the chip-flow model has implemented accurate 35 representations of the cutting tool geometry as shown in Figure 11C. This is a critical part of the chip-flow WO 93/01537 PCT/US92/05172

-29-

models since the subsequent chip shape and reactions on the cutting tool are a function of the 'chip-breaker' geometry (shape of the cutting tool surface).

5 D. Three-Dimensional Analysis

All prior work in chip-flow modeling has centered on two-dimensional simulations. Such simulations attempt to model the 'orthogonal' cutting process in lathe operations, or other cutting processes where the inclination 10 angle is zero (such as broaching). Most cutting operations, however, are three-dimensional in both geometry and boundary conditions.

The simulations performed in three dimensions according to the present invention are executed pursuant 15 to the flowchart of Figure 2B in the same manner as the two-dimensional chip/tool analysis in Figure 2A, except that the 3D simulations require 3D geometry and mesh descriptions (steps \underline{w} and \underline{x}), and utilize the ABAQUS *DYNAMICS procedure (discussed below) including a novel 20 finite element technique known as an explicit dynamics formulation for exercising the model. This formulation is especially suited to problems where large, high speed deformations occur. The debonding formulation previously described was included in the three-dimensional model, 25 but was expanded such that the chip tears away from two surfaces of the workpiece material, rather than one as in the two dimension cutting simulations.

Figure 12B illustrates the three-dimensional nature of the cutting process with a non-zero inclination angle, 30 while Figure 13 illustrates the 3D temperature gradients in the chip. It is expected that the tool designer will use such a three-dimensional simulation when it is felt that two-dimensional analyses are insufficient, such as at the end of the design cycle.

Explicit Dynamics Time Integration

The equations of motion for the chip-flow problems are

$$\nabla^* \mathbf{T} - \rho \ddot{\mathbf{u}} + \rho \mathbf{f}_{\mathbf{R}} = 0, \tag{9}$$

5 where ρ is the mass density per unit volume, \ddot{u} is the acceleration of the material point, and f_B is a specific (force per mass) body force vector, T is the true stress in the deformed configuration.

We seek the solution to Equation (9) subject to the 10 boundary conditions

$$u = f(t) \text{ on } S_{ij}, \tag{10}$$

where S_u represents the portion of the boundary on which kinematic quantities are specified (displacement, velocity, and acceleration). In addition to satisfying 15 the kinematic boundary conditions given by Equation (10), we must satisfy the traction boundary conditions

$$T*n = s(t) \text{ on } S_{T}, \tag{11}$$

where S_T represents the portion of the boundary on which tractions are specified. The boundary of the body is 20 given by the union of S_u and S_T , and we note that for a valid mechanics problem, S_u and S_t have a null intersection.

The jump conditions at all contact discontinuities must satisfy the relation

25
$$(T^+ + T^-)*n = 0 \text{ on } S_C,$$
 (12)

where S_C represents the contact intersection, and the superscripts "+" and "-" denote different sides of the contact surface.

The Lagrangian form of the continuity equation is 30 written as

$$\dot{\rho} - \rho trD = 0. \tag{13}$$

This is satisfied trivially in our formulation since we do not allow mass transport. Equation (13) degenerates to

$$\rho V = \rho_O V_O, \qquad (14)$$

where V is the volume, and the subscript "0" denotes a reference configuration.

The conservation of energy principle equates the increase in internal energy per unit volume to the rate 5 at which work is being done by the stresses plus the rate at which heat is being added. In the absence of heat conduction.

$$E_{v} = \rho \left(\Delta E_{m} / \Delta t\right) = \sigma : d + \rho \dot{Q}$$
 (15)

where E_{v} is the energy per unit volume, E_{m} is the energy 10 per unit mass, and \dot{Q} is the heat rate per unit mass, σ the stress, and d the strain rate.

ABAQUS uses a modified central difference scheme to integrate the equations of motion through time. By this we mean that the velocities are integrated with a forward 15 difference, while the displacements are integrated with a backward difference. The integration scheme for a node is expressed as

$$\ddot{u}_{t} = (f_{t}^{EXT} - f_{t}^{INT})/M$$

$$\ddot{u}_{t+\Delta t} = \ddot{u}_{t} + \Delta t \ddot{u}_{t}$$

$$u_{t+\Delta t} = u_{t} + \Delta t \ddot{u}_{t+\Delta t}$$

$$(16)$$

$$(17)$$

$$\ddot{\mathbf{u}}_{t+\Delta t} = \ddot{\mathbf{u}}_t + \Delta t \ddot{\mathbf{u}}_t \tag{17}$$

$$u_{t+\Delta t} = u_t + \Delta t \ddot{u}_{t+\Delta t}$$
 (18)

 f_{t}^{EXT} and f_{t}^{INT} are the external and internal nodal forces, respectively, M is the nodal point lumped mass, and Δt is the time increment.

The central difference operator is conditionally stable. It can be shown that the stability limit for the operator with no damping is given in terms of the highest eigenvalue in the system (ω_{max}) :

$$\Delta t \le 2/\omega_{\text{max}} \tag{19}$$

30 Equations (9) through (18) were discretized in the usual finite element manner for 8-noded hexahedron A complete description of this process is provided by Taylor et al. in "Pronto Three-Dimensional Transient Solid Dynamics Program," 35 SANDIA report SAND87-1912, V6-32 (March 1989).

10

20

25

E. Cutting Simulation

A tool study was performed in accordance with the present invention by simulating the cutting of an AISI 4340 steel workpiece with two different hardening rates, 5 while other cutting parameters (depth of cut, speed, feed, and tool orientation) were held constant.

The following cutting conditions were used:

- Cutting tool:TiC-coated WC-Co flat tool without chip breaker.
- Coulomb coefficient of friction, μ =0.10
- Rake angle = 10°
- Inclination angle = 10°
- Cutting speed = 1.75 m/s
- Feed = 0.127 cm.
- The AISI 4340 material properties are as follows:
 - Shear modulus, $2\mu = 150 \times 10^9 Pa$
 - Bulk modulus, $K = 196.1 \times 10^9 Pa (v = 0.33)$
 - Initial Yield, $\sigma_0 = 800 \times 10^6 Pa$
 - Hardening modulus, $H = 500 \times 10^6 Pa$ and $100 \times 10^{-3} Pa$
 - Initial temperature, $T_0 = 0 \text{ K}$
 - Stress intensity factor, $J_{IC} = 87600 \, \text{Nm/m}^{1.5}$
 - Thickness of bond material layer, t = 0.5 mm
 - Adiabatic factor, $1/\rho c_{xy} = 2.618*10^{-7} \text{ m}^3/\text{J-K}$
 - $e_f = 0.438$ [from Equation (4)]
 - Plastic work heat fraction, Wp = 1.0

The mesh of the uncut workpiece is shown in Figure 12A. The mesh contained 2048 8-noded solid elements and 832 debonding elements containing a total of 3980 nodes. 30 The cutting simulation was run for 15.0 µs, enough time to allow substantial curling of the chip over the rake face of the tool. Solution data (stress components, strains, strain rates, invariants, temperatures, etc.) was written to disk every 0.25 µs, so that 60 "snapshots" 35 of deformation were recorded, permitting animation of the

time-dependent solution variables. Computation time for the three-dimensional simulation was 32 cpu hours on a VAX 8800. This means that depending on the number of other processors currently running, the simulation turn-around could vary from 2 days to 1 week (wall-clock time) on a machine of equivalent capabilities.

The first simulation with hardening rate of 500E6 Pa simulated 4340 steel, while the second was a nearly elasto-plastic material which could be thought of as a 10 4340 steel at elevated temperatures. Figures 12A and 14 show the mesh of the chip at t=0 s, illustrating the tool orientation and position of the debonding elements. Note the rake and the inclination angles of 10°.

During the three-dimensional cutting simulation, 15 many time-dependent parameters were calculated at every node and gauss point in the mesh for every iteration during the solution process. These parameters include deformation, strain, strain rate, stress, principal stresses and strains, von Mises, tresca, and hydrostatic 20 components, temperatures, plastic strain, and actively yielding flags.

Results are presented for the H = 500E6 Pa case first, followed by the H = 100E-3 Pa case. Figure 15 illustrates the deformation of the chip at an 25intermediate time step in the solution procedure, with the chip being in thermal and mechanical equilibrium. Note the curling of the chip in several directions, opposed to the single radius of curvature found by similar two-dimensional models. Heat is generated in the 30 models by fracturing of the chip from the workpiece, friction along the tool-chip interface, and by plastic deformation of the workpiece material. This heat generation was fully discussed hereinabove in connection with the thermal coupling phenomenon. We have assigned 35all of this work to the generation of heat in the chip volume, although other assignments are possible within

the scope of the invention. Other researchers have concluded that little heat is transferred into the uncut material of the workpiece, substantiating this assumption. The temperature distribution in the chip would be reduced when conduction into the cutting tool convection and radiation terms are fully modeled. Furthermore, a more accurate temperature-dependent material model for the workpiece would further reduce the maximum chip temperature.

10 The deformed shape at an intermediate time interval for the H=100E-3 Pa case (Figure 16) shows the change in chip shape for a lower hardening rate material. Note the increased contact zone in these figures, compared to the case with the larger hardening rate. Figure 17
15 illustrates the distribution of the von Mises stress in the deformed chip at this time interval of the solution.

The successful simulation of the chip-flow process in three-dimensions facilitates an analysis of metal flow over the tool face. Three-dimensional simulations

20 clearly give much more information about the morphology of the chip in its deformed state. Chip curl radii in several directions can be easily resolved from the images of the deformed shapes, or directly from the solution data. This information is useful in the "numerical construction" of chips-boards to judge the application range for a given tool and workpiece geometry. The higher hardening rate material provides a tighter chip radius since the stress state through the thickness of the chip is much less uniform, resulting in a tendency to 30 curl the chip.

The tighter chip curl radius also results in a lower contact area (patch) for the H = 500E6 Pa case. This could conceivably reduce wear and heat transfer in the rake face of the chip, depending upon the reaction forces 35 and temperatures in the contact zone. This information on the contact region is also indicative of how cutting

tool edge geometry will effect the morphology of the chip. For instance, small t-landed edge designs will have little effect on resulting chip shape for elasto-plastic materials.

The curling of the chip in several directions can provide a means to investigate the breakage of the chip from the workpiece. For example, if the chip curls in a manner such that it hits the just-machined surface of the workpiece, or curls back and hits the tool holder, the 10 force encountered during this impact is usually sufficient to break the chip away. This is frequently seen in the machining of steel workpiece materials. In order to predict chip lengths from models, bending moments could be applied to curled chips of various 15 lengths to determine the final chip size.

The highest temperatures encountered in the chip occur at the intersection of the planes containing the debonding element. This has been demonstrated in infrared temperature measurements of the cutting process.

20 In the numerical model, this temperature peak in the chip occurs because the energy released in fracturing the chip all goes into the creation of heat energy, and also because this is a corner of the chip, so the heat transfer rate is smaller than if this heat source was 25 located at the center of the chip volume.

Several enhancements can be made in the model prior to use in a tool-design environment. These include a more accurate material model for the workpiece, which would require temperature and strain-dependent material 30 properties, and temperature-dependent fracture toughness for the debonding element. Also, specific cutting tool chip breaker geometries could be used as input for the analyses. Lastly, improvements in computer speed and visualization would be required for improved post 35 processing of the large data sets created during a three-dimensional simulation of the cutting process.

The above results demonstrate the possibility of using three-dimensional cutting simulations to support cutting tool design. In fact, the computational time to complete the three-dimensional chip-flow analysis is manageable with a minisupercomputer, thus making this a viable method of a alyzing the chip formation process for turning and milling operations.

The linear finite element analysis of the present invention has been applied to the design of a ceramic 10 chipbreaker disclosed in U.S. Patent No. 4,963,061.

II. Artificial Intelligence

Once the mathematical models have been exercised to provide predictive performance results of the tool 15 response and chip-flow simulation, the results are reviewed by an artificial intelligence (AI) module 18 in Figure 1. (Steps <u>aa-gg</u> in Figure 2C).

In accordance with the present invention, each simulation model can be represented, for illustrative 20 purposes only, by a function y=f(x) wherein x is an input vector of modifiable parameters, and f(x) is the series of mathematical relationships between the input x and output vector y. In the present invention, f(x) will be an implicit function of the design variables x, since a 25 suitable chip-flow analysis using ABAQUS is necessary to find the function f(x) for a given set of x.

The AI system includes a hierarchical structure of rules for comparing the predicted **y** vector to predetermined acceptability criteria **y'**. (Step <u>ee</u>). This 30 rule-based comparison produces a judgment which indicates whether the predicted response is acceptable or unacceptable within the constraints of the rule. (Step <u>ff</u>).

Based on these judgments, a recommendation is made 35 to modify the defining relationships of the model represented by f(x) and/or modify the parameters of the

input vector \mathbf{x} . (Step \underline{gg}). Specifically, the new design parameters of the chip-flow and tool models are returned to the mesh and model-generating steps \underline{m} , \underline{n} , and \underline{w} for constructing new models to be exercised. (Step \underline{ii}).

- Thus, it is apparent that the AI system performs a rule-based comparison module, renders judgments based on the comparison, provides a recommendation embodying said judgment, and modifies the model/input parameters in accordance with the recommendation.
- 10 Figure 19 illustrates the decision-making process involved in a rule-based system for evaluating the design of a cutting tool, and is representative of the logic flow of the AI module 18 for tool response and chip-flow simulations. The tool design is characterized by 15 parameters such as land-width, land-angle, chip-breaker depth, form-width, incident-angle, and other variables relating to the geometry and angles of a chip-breaker design on the cutting nose of the tool insert. These listed measures are only a representative list as it 20 should be well known to those skilled in the art that other measures are also included.

As indicated in Figure 19, these variables are applied to rule-based decision blocks embodying tool requirements relating to such evaluative measurements as 25 geometric characteristics, stress, and temperature levels. Based on the acceptability of these measurements, the design variables are appropriately modified until an acceptable design is achieved.

In accordance with Figure 19, an AI module for 30 evaluating tool and chip-flow simulations would use characteristics such as chip size, chip radii, chip thickness, localization, and other such parameters available from chip-board matrices to evaluate the simulations. In particular, a design vector of the 35 above-identified variables is used to design a tool such

that tool failure does not occur and suitable chip-control is obtained.

In order to implement AI module 18, a set of pre-existing rules on the strength of the tool material, 5 and acceptable sizes and shapes of the resultang chips would be stored within the cutting tool data base. At every tool design iteration (i.e., after a chip-flow or cutting tool analysis), the chip size and stresses within the cutting tool would be compared to the values in the 10 database. Any conditions that are violated will necessitate computation of the appropriate changes in the design variables such that the rule-based judgments in subsequent iterations will converge to an acceptable design.

- As discussed above, and outlined in the instruction sets of the Appendix, the present invention provides as an input deck to ABAQUS a description of the chipbreaker geometry and boundary conditions; node coordinate specifications; element definitions for chip, spokes, 20 bonds, and tool-chip interfaces; stress-strain curve data; material property definitions; and analysis type. It should be apparent to those skilled in the art that modifications can be made to the instruction sets to supplement the analysis with other ABAQUS subroutines.
- Once analysis results are produced, the simulation is evaluated. For example, in the drawings of Figures 22 and 23, the degree of localization in the primary shear zone is used to compare the relative merits of designs #1 and #2. If the analysis is modified to allow for chip removal, data available from chip-board matrices, such as chip size, radii, and thickness, is used to evaluate chip control.

Although the analysis for designs #1 and #2 differ only in the chip-breaker geometries being analyzed, the 35 representative set of parameters for the input deck listed above can be modified on subsequent iterations.

However, if such parameters are fixed to correspond to a desired cutting environment, the chipbreaker geometry is changed by modifying the interface element definition until an acceptable chip-flow simulation is achieved.

5 Other analyses which a designer may review in conducting the simulations include temperature distributions, reaction forces on the contact surfaces, and stress-strain levels.

In the present invention, the knowledge base for the 10 expert system is derived from the material and VTAS database from all previous tool trials. The inference engine is a program which controls the testing of internals rules, or "IF-THEN" statements which make judgments on the current tool design.

- Incorporated herein by reference are the following United States patents which are instructive of the field of artificial intelligence: U.S. Patent Nos. 4,949,278, 4,918,620, 4,648,044, 4,866,635, 4,595,982, and 4,967,368.
- While each programmable function and operation executed by the algorithms of the present invention consists of one or more equations embodied in a numerical model, the invention is not so limited to models with specific relationships between the input and output 25 variables.

In certain applications to be represented by an expert system, the required relationship between variables may be too complex to be represented by an equation. In such cases, it may be necessary to 30 extrapolate the desired result from available data. One way to accomplish this extrapolation function is by including a neural-net in the system model section of the expert system architecture of the present invention. A neural-net is a software simulation of a parallel 35 distributed processing system in which each node is similar to a neuron and connected to all other nodes. In

typical applications as known in the art, neural-nets are used either for pattern association, where a set of patterns are associated with another set of patterns, or for auto-association, where a partial input pattern is 5 associated with its complete pattern. In applying neural-nets to the present invention architecture, the neural-net is utilized to associate a set of input data with a set of output data. The data module provides the user with an input and an output file. Using these 10 files, the user enters into the system a set of input and output data. The data module then calls the neural-net software and passes to it the information contained in Using this data, the neural-net software these files. learns the relationship between the input and output This relationship is stored in the neural-net as weights, or strength of connections, between input and output nodes representative of the input and output Subsequently, the data module asks the user variables. for a set of new input parameters. The data module then 20 passes the new input data to the neural-net. Using the weights between input and output nodes, the neural-net software determines the output data associated with the input data submitted by the user. Thus, the operating flexibility of the expert system can be enhanced by use 25 of neural-net technology. A brief description of performance of pattern association by neural-nets is provided in the reference entitled "Parallel Distributed Processing" by Rumelhart, et al., Vol. 1, page 446, the

While in accordance with the architecture of the preferred embodiment of the present invention the various software functions performed within the system architecture are each designated as part of one of the architecture modules, the invention is not so limited. As will 35 be recognized by those skilled in the art, the designations of program and data modules as well as the

MIT Press, Cambridge, MA.

other architectural components, while preferred herein, are primarily for convenience in organizing the various program functions. To some extent, the various functions could be allocated differently among the architectural 5 modules or, alternatively, different modules could be designated and program functions assigned thereto, all without affecting expert system operation.

III. Database Creation

The database module shown in Figure 1 interacts with the simulation modules 16 and 17 of both the chip-flow and tool responses, respectively, and with the AI module 18 in rendering new tool designs.

Presently, the database implemented in the system of 15 Figure 1 is the Valenite Tooling and Analysis Software (VTAS) package available from GTE Valenite Corporation of Troy, Michigan. VTAS receives basic information from a user about the cutting application, such as speeds, feeds, and materials, and executes algorithms to match 20 the characteristics of the cutting operation to the best choice in tool grade and geometry. This method has the advantage of being able to extrapolate information from a limited amount of internal and external data to make useful recommendations on almost any cutting operation.

VTAS combines a materials database with a cutting database as shown in Figure 18. The following list of database parameters should not serve as a complete recitation of the data values available to the analysis module 12, but rather as an exemplary subset of 30 parameters whereby other parameters should be readily appreciated by those skilled in the art to be included in the present invention.

The cutting database includes empirically determined information about the cutting condition and machining 35parameters. The cutting condition includes data on such parameters as cutting speed, feed, and depth of cut,

while the machining parameters include data on static and dynamic factors, operational features (turning, milling, drilling, thread cutting), and thermal effects.

Parameters such as forces and temperatures are acquired by equipment well known in the art for monitoring cutting operations, such as the ISAAC 5000 Data Acquisition system, infrared sensors, and the Dynametrics measurement assembly.

The materials database includes primary physical and 10 mechanical properties of the tool and workpiece. For example, cutting tool parameters include tool geometries, chip form (chipbreaker designs and constraints), bit grade, deflection shoulders, loadabilities, working ranges, and suitability for different workpiece 15 materials, cutting conditions, stabilities, cutting rates, chip cross-sections, and individual processing methods. Workpiece properties include treatment conditions, hardness, alloying components, mechanical strength, surface conditions, machining behavior, and raw 20 and finished dimensions.

The material properties and cutting conditions together provide the boundary conditions of the cutting operation. U.S Patent No. 4,992,948, hereby incorporated by reference, discloses a data processing unit accessing 25 a database for controlling a machine tool.

The VTAS database is continually modified as new workpiece materials, tool inserts and tool materials are studied. Similarly, when some contents of the database become obsolete, they will be removed from the database. 30 Also, simulation results are included in the database, and can be easily modified when new models which describe the cutting process are derived. The results from the simulation studies which are to be included into the machinability database do not include any experimentally-35 determined variables (such as chip thickness) in the analysis. This means that only primary physical and

mechanical properties of the tool and the workpiece (such as stiffness, thermal conductivity, and yield strength) are used to simulate machine tests. This analysis is supplemented by database information on forces and temperatures of the cutting operation, which are measured from actual cutting operations.

It should be obvious to those skilled in the art that a computer-accessible and modifiable database other than VTAS is implementable in a computer system and 10 therefore forms a part of the present invention, wherein such a database combines machining data, materials data, cutting operation information, and results of simulated and real-time tool studies.

15 IV. Animation/Results Evaluation

Chip-flow modeling generates very large data sets, since all parameters (temperature, stresses, strains, invariants) are monitored for every increment in the Such large volumes of information require simulation. 20 novel visualization techniques for interpretation of the data. Previous work has centered on contour plots (still images), or frame-by-frame animation of the incremental data. GTE Laboratories Incorporated of Waltham, Massachusetts, has produced an animation system which 25 allows the tool designer to interact with the data set as it is being visually represented. Currently, the deformation and a single time-dependent parameter (such as temperature) may be monitored during the animation. The animation tools, however, are modifiable to permit 30 the simultaneous rendering of several time-dependent parameters.

V. Manufacturing of Tool

Once the decision module 19 in Figure 1 determines 35 that the tool design is acceptable, system control is awarded to the manufacturing module 11 for fabricating a

WO 93/01537 PCT/US92/05172

-44-

physical tool prototype as discussed in section A. below, or for fabricating a plastic tool prototype as discussed in section B. below. (Step <a href="https://doi.org/10.1001/jhb.no.1001

A. CAD-CAM Integration

A computer-aided design (CAD) module 10 in Figure 1 is employed by GTE Valenite Corporation of Troy, Michigan, in generating tool prototypes based on acceptable tool designs using a Unigraphics workstation to produce three-dimensional tool geometries which are 10 directly downloaded to a chip form module 21. Module 21 preferably includes a 4-axis mill for cutting a tool form with the desired chipbreaker design.

A computer-aided manufacturing (CAM) module 23 receives the tool form and produces a physical cutting 5 tool. However, the fabrication of a physical tool prototype with a conventional CAD/CAM system possesses the following disadvantages:

- Inability to incorporate, enhance, and manufacture more sophisticated design elements in chipbreaker geometries.
- Difficulty in transferring accurate dimensional design details into manufacturing.
- Time restraints on receipt of engineering prints and hard tooling.
- 25 Additional manufacturing time needed to incorporate improved design changes.
 - Accuracy/repeatability of ground prototypes.
 - Performance changes are not easily implemented from ground prototype to final pressed product.
- Transfer of dimensional design requirements on additional styles.
 - Manufacturing time needed to produce test pieces.

20

30

B. Plastic Tooling

The present invention preferably utilizes the conventional CAD/CAM assembly discussed above with a novel process employing plastic as a die material for 5 producing plastic tool prototypes. The plastic tooling process is directed to a method for making a compact for a densified cutting insert of a hard refractory material having a predetermined desired shape, comprising the following steps: (i) forming a machinable wax material 10 into the predetermined desired shape, (ii) contacting the shaped machinable wax material with an uncured flowable liquid moldable plastic material and curing the moldable plastic material to form a substantially incompressible solid plastic mold, and (iii) compacting a powdered 15 mixture comprising an organic binder and hard refractory particles into contact with the mold at a sufficient pressure to form a compact having the predetermined desired shape.

This plastic tooling process is disclosed in U.S. 20 Patent No. 5,075,053 issued December 24, 1991, to Thomas J. Bernadic et al. entitled "METHOD OF MAKING CUTTING INSERTS" which patent is incorporated by reference into the present application.

The advantages of a CAD/CAM system implementing 25 plastic tooling include the following:

- Ability to incorporate, enhance, and manufacture more sophisticated design elements in chipbreaker geometries.
- Produce 3-D models of required chipbreaker designs via a CAD system.
- Produce machining coordinates via CAD/CAM link to 4-axis milling machine to produce press tooling.
- Substantial time savings for improved design changes.

- Repeatability/accuracy of each chipbreaker design is machine tested.
- Accurate Translations of required chipbreaker design into manufacturing.
- 5 Improved manufacturing times on engineering drawings and hard tooling.
 - Complete design requirements on additional styles before producing hard tooling sets.
- Quick response for capturing smaller mark 10 windows.
 - Taking designs risks without high up-front costs.

The plastic tooling of prototypes in combination with the optimal designing of cutting tools by performing 15 simulations of various cutting operations offer tool designers significant savings in development time and engineering resources.

Advantageously, CAD/CAM plastic tooling in accordance with the present invention has been employed on light duty tool standards development and customer-requested special deliveries, and has potential uses in the actual manufacture of tool inserts.

IV. EXTENSIONS

This invention greatly reduces the time required to design and select cutting tools by virtually eliminating the trial and error process currently used, and replaces it with an integrated CAD/CAM, machinability database that has retrievable information from all previous 30 machinability studies performed, on-going machinability studies, and the results from simulating the chip-flow process by detailed numerical models of the material removal process. The key element is the integration of the database with the CAD, CAM and numerical simulations, 35 tailored specifically for cutting tool manufacturing (Figure 1).

It should be readily appreciated by those skilled in the art that such a system as described herein can serve as a manufacturing cell responsive to customer requests for providing either a tool design or a plastic tool 5 prototype based on this design. In particular, a customer's request may include a description of the desired tool materials, workpiece, and cutting environment from which the simulated machinability studies of the present invention can provide a range of 10 tool designs with associated performance measures for review and selection by the customer. Once an optimal design is chosen pursuant to the customer's special requirements, a plastic tool prototype can be manufactured, or preferably a set of prototypes with 15 different designs are manufactured for testing and evaluation since the plastic tooling process affords such batch production in a short period of time.

The following is a summary of the modules in the cutting tool system of the present invention along with 20 the benefits and opportunities available with each such module.

CAD/CAM

- Increase manufacturing efficiency on special short run jobs.
 - Reduction in time/manpower/cost by utilizing plastic tooling.

DATABASE

- Real-time process control.
- On-demand benchmarking information.

TIME-SHARING

- Common FEA resource for engineering applications.
- Capability for modeling of complex problems such as milling and drilling.
- Linkage of material/tool/toolholder models.

WO 93/01537 PCT/US92/05172

-48-

SUPER-COMPUTING NETWORK

• Improving speed of ABAQUS calculations.

CHIP-BREAKER DESIGN

- Short term tool optimization on specific job applications.
- Field accessible resource for problem solving.

FAILURE ANALYSIS

Performance predictions based on physical property measurement.

- "Expert system" based grade selection.
 - Product analysis in terms of manufacturing tolerances.

While preferred embodiments have been illustrated and described herein, it will be obvious that numerous 15 modifications, changes, variations, substitutions and equivalents, in whole or in part, will now occur to those skilled in the art without departing from the spirit and scope contemplated by the invention. Accordingly, it is intended that the invention herein be limited only by the 20 scope of the appended claims.

25

5

10

30

35

-49-

APPENDIX TO SPECIFICATION PAGE 1 of 26

```
*HEADING, UNSYMM
RATE INDEP, 10 DEGREE RAKE (FROM VERTICAL)
SPEED - 1.75 M/S, FRICTION-0.5, GRADED MESH
DEBONDING ELEMENT
**WAVEFRONT MINIMIZATION, SUPPRESS
** put restart at a freq. of 1000 to write only LAST iteration *RESTART, WRITE, FREQ-1000
** NODES
**
*NODE, SYSTEM-C
1, 0.10033, 90.000
1001, 0.10033, 90.000
9001, 0.10160, 89.945
*NSET, NSET-BL
1001
*NSET, NSET-TL
9001
*NFILL, BIAS=0.8, NSET=LHS
BL, TL, 8, 1000
*NSET, NSET-LHS, GEN
1, 9001, 1000
*NCOPY, OLD SET-LHS, CHANGE NUMBER-1, SHIFT, MULTIPLE-64, NEW SET-ALL
0., 0., 0.
0., 0., 0., 0.,
*NSET, NSET-ALL
                0., 0., -1., 0.159
LHS
*NSET, NSET-BOT, GEN
1001, 1065, 1
*NODE, NSET-MASTER
50001, 0., 0.
*NCOPY, OLD SET-MASTER, CHANGE NUMBER-1, SHIFT, MULTIPLE-64
0., 0., 0.
0., 0., 0.,
               0., 0., -1., 0.0
*NSET, NSET-CENTER, GEN 50001, 50065, 1
*NODE, NSET-TOOL
60000, 0.0, 0.10033
** DEFINE ELEMENTS
**
**
      CHIP
*ELEMENT, TYPE=CPE4
1001, 1001, 1002, 2002, 2001
```

فيطاحا الماساء السامين اداء الماسية

-50-

APPENDIX TO SPECIFICATION PAGE 2 of 26

```
*ELGEN, ELSET=CHIP
1001, 64, 1, 1, 8, 1000, 1000
*SOLID SECTION, ELSET-CHIP, MAT-ST4340
*MATERIAL, NAME-ST4340
*ELASTIC
209.0E9, 0.33
*PLASTIC
** this is the "CHIP8" stress - strain curve
 800.0E6, 0.00
850.0E6, 0.10
 800.0E6, 0.25
 750.0E6, 0.50
 700.0E6, 1.00
 700.0E6, 1.25
 700.0E6, 1.50
 700.0E6, 2.00
***RATE DEPENDENT
** 40.0, 5.0
*SPECIFIC HEAT
**J/kg -K
599.13
*DENSITY
**kg/m**3
770ō.0
*CONDUCTIVITY
**W/m-K
43.0
***EXPANSION
** /K
**21.6E-6
*INELASTIC HEAT FRACTION
1.0
**
     SPOKES
Ħπ
*FILEMENT, TYPE-B21, ELSET-SPOKE
50001, 50001, 1
*ELGEN, ELSET-SPOKE
50001, 65, 1, 1
*BEAM SECTION, MAT-SPOKE, ELSET-SPOKE, SECT-RECT
** WIDTH, DEPTH
1.0, 0.1
*MATERIAL, NAME-SPOKE
*ELASTIC
209.0E9, 0.33
**
      BONDS
**
*USER ELEMENT, TYPE-U1, NODES-4, COORDINATES-2, PROP-7, VAR-2, UNSYMM
*UEL PROPERTY, ELSET-BOND
** E1, E2, EP1, EP2, EZ1, EZ2, THICK
** WHERE THICK*EZ1 = 2*J1C/SIGY1,
                                           THICK*EZ2 = 2*J2C/SIGY2
     AND SIGY2 = SIGY1/2 AND E2 = E1/(2*(1+NU))
** J1C = J2C = 87600 N-M/M**2 (= 500 IN-LBF/IN**2)
200.0E9, 75.2E9, 4.0E-3, 5.33E-3, 3.65, 7.30, 0.06E-3
```

-51-

APPENDIX TO SPECIFICATION PAGE 3 of 26

```
*ELEMENT, TYPE=U1, ELSET=BOND
 1, 1, 1001, 1001, 1002
2, 2, 1002, 1001, 1003
65, 65, 1065, 1064, 1065
*ELGEN, ELSET-BOND
2, 63, 1, 1
**
**
      TOOL-CHIP INTERFACES
*ELEMENT, TYPE-IRS21, ELSET-INTER
60001, 1001, 1002, 60000
61001, 1001, 2001, 60000
*ELGEN, ELSET-INTER
        64, 1, 1
8, 1000, 1000
60001, 64,
61001,
** DESIGN 1 INTERFACE ELEMENT DEFINITION (UNITS - METERS)
*RIGID SURFACE, TYPE-SEGMENTS, ELSET-INTER, SMOOTH-.0381E-03
** 1 MM HAS BEEN ADDED TO ALL 'Y' VALUES
START, 0.0, 107.33E-03
LINE, 0.0, 100.37E-03
LINE,
        -.19558E-03, 100.33E-03
LINE, 0.0, 99.33E-03
*INTERFACE, ELSET-INTER
LINE,
*FRICTION
0.0, 1.0E12
**
*BOUNDARY
TOOL,
        1, 2,
                   0.0
CENTER, 1, 2,
                  0.0
*INITIAL CONDITIONS TYPE-TEMP
ALL, 0.0
*FLSET, ELSET-MODEL
CHIP, INTER
***PLOT
***DETAIL, ELSET-MODEL
***DRAW
*USER SUBROUTINE
       SUBROUTINE UEL(RHS, AMATRX, SVARS, ENERGY, JLINES, XVAL, NDOFEL, NRHS,
      1 NSVARS, PROPS, NPROPS, COORDS, MCRD, NNODE, U, DU, V, A, JTYPE, TIME, DTIME
      2 KSTEP,KINC,JELEM,PARAMS,NDLOAD,JDLTYP,ADLMAG,PREDEF,NPRED,LFLAGS)
C
       THIS ROUTINE BELONGS IN MAIN
                                                                            LAST UPDATE
000000
       THIS ROUTINE DEALS WITH A 4-NODED DEBONDING ELEMENT. THE INITIAL BOND
       IS BETWEEN NODES 1 AND 2. NODES 3 AND 4 ON THE 'MASTER' SURFACE ARE USED ONLY FOR CALCULATING A SURFACE AREA. IT CALLS SUBROUTINE BOND
       TO PROVIDE THE STRESSES AND MATERIAL TANGENT STIFFNESSES FOR THE
       BONDING MATERIAL.
       IMPLICIT REAL*8(A-H.O-Z)
       PARAMETER (ONE=1.0, ZERO=0.0, NTENS=2, LU=50)
      DIMENSION RHS(NDOFEL, NRHS), AMATRX(NDOFEL, NDOFEL), SVARS(1), 1 ENERGY(6), JLINES(1), XVAL(1), PROPS(1), COORDS(MCRD, NNODE),
      2 U(NDOFEL),DU(NDOFEL),V(NDOFEL),A(NDOFEL),TIME(7),DTIME(7),
```

APPENDIX TO SPECIFICATION PAGE 4 of 26

```
3 PARAMS(1), JDLTYP(NDLOAD, NRHS), ADLMAG(NDLOAD, NRHS, 2),
      4 PREDEF(NPRED, NNODE, 2), LFLAGS(4)
     E ,STRESS(NTENS),DDSDDE(NTENS,NTENS),STRAN(NTENS)
       COMMON/CLINES/VERSN, DAT(2), TIM, NLPAGE, KLINE, KPAGE, JINP, JOUTP
c
       INCLUDE 'ABQ47: [ABQ7.CMN1] CONSTS.CMN/LIST'
cc
       SAVE KOUNT, INCOLD
DATA KOUNT/0/ INCOLD/1/
C
        KOUNT - KOUNT + 1
        IF (KOUNT.EQ.1) THEN
C
           OPEN(UNIT-LU, FILE='TEST.DBG', STATUS='NEW')
        ENDIF
CC
        IF (KINC.NE.INCOLD) WRITE(LU,*) ' '
        INCOLD - KINC
C
        WRITE(LU, 100) KSTEP, KINC, JELEM, KOUNT
   100 FORMAT(' KSTEP = ',12,' KINC = ',15,'
1 ' JELEM = ',15,' KOUNT = ',16
CC
        WRITE(LU, *) 'U'
Č
       WRITE(LU,*) (U(I), I=1, NDOFEL)
C
      DO 20 JDOFEL-1, NDOFEL
      RHS(JDOFEL,1) - ZERO
      DO 20 IDOFEL-1, NDOFEL
   20 AMATRX(IDOFEL, JDOFEL) - ZERO
C
      DAM = SVARS(1)
      IF (DAM.GE.ONE) RETURN
      THICK - PROPS(7)
      ALPHA = 0.5
CCC
      COMPUTE ELEMENT AREA/LENGTH
      X2 - COORDS(1,2)
      Y2 = COORDS(2,2)
      X3 = COORDS(1,3)
      Y3 = COORDS(2,3)
      X4 = COORDS(1,4)
      Y4 = COORDS(2,4)
      ALEN23 = DSQRT((X3-X2)*(X3-X2) + (Y3-Y2)*(Y3-Y2))
ALEN24 = DSQRT((X4-X2)*(X4-X2) + (Y4-Y2)*(Y4-Y2))
      ALEN = (ONE-ALPHA) *ALEN23 + ALPHA*ALEN24
C
      COMPUTE STRAINS
C
      STRAN(1) = (U(4) - U(2))/THICK
      STRAN(2) = (U(3) - U(1))/THICK
      COMPUTE STRESSES AND MATERIAL TANGENT STIFFS AND UPDATE DAMAGE
C
      CALL BOND(STRESS, SVARS, DDSDDE,
                  STRAN
     3
                  NDI, NSHR, NTENS, NSVARS, PROPS, NPROPS)
C
      XNN = DDSDDE(1,1)*ALEN/THICK
      XNS = DDSDDE(1,2)*ALEN/THICK
      XSN = DDSDDE(2,1) *ALEN/THICK
```

-53-

APPENDIX TO SPECIFICATION PAGE 5 of 26

```
XSS - DDSDDE(2,2) *ALEN/THICK
      FN - STRESS(1)*ALEN
          - STRESS(2)*ALEN
      FS
       WRITE(LU,*) 'XNN, XNS, XSN, XSS, FN, FS' WRITE(LU,*) XNN, XNS, XSN, XSS, FN, FS
CCCCC
      STIFFNESS MATRIX
      AMATRX(1,1) = XSS
      AMATRX(1,2) = XSN
      AMATRX(1,3) = -AMATRX(1,1)
      AMATRX(1,4) = -AMATRX(1,2)
      AMATRX(2,1) = XNS
      AMATRX(2,2) - XNN
AMATRX(2,3) - -AMATRX(2,1)
      AMATRX(2,4) = -AMATRX(2,2)
      AMATRX(3,1) = -AMATRX(1,1)
      AMATRX(3,2) = -AMATRX(1,2)
      AMATRX(3,3) =
                      AMATRX(1,1)
      AMATRX(3,4) = AMATRX(1,2)
      AMATRX(4,1) = -AMATRX(2,1)
      AMATRX(4,2) = -AMATRX(2,2)
      AMATRX(4,3) =
                      AMATRX(2,1)
      AMATRX(4,4) =
                      AMATRX(2,2)
      RESIDUAL CONTRIBUTION
      RHS(1,1) = FS
      RHS(2,1) = FN
      RHS(3,1) = -RHS(1,1)
      RHS(4,1) = -RHS(2,1)
C
      RETURN
      END
C
C
      SUBROUTINE BOND (STRESS, STATEV, DDSDDE,
     2
                        STRAN,
                       NDI, NSHR, NTENS, NSTATY, PROPS, NPROPS)
      BONDING MATERIAL. THE BEHAVIOUR IS ELASTIC-FRACTURING IN
      TENSION AND SHEAR AND ELASTIC IN COMPRESSION.
          : YOUNG'S MODULUS IN COMPRESSION AND INITIALLY IN TENSION
      EP1 : STRAIN AT PEAK COMPRESSIVE STRESS
      EZ1 : STRAIN AT ZERO/FRACTURED STRESS
          : SHEAR MODULUS
      E2
      EP2 : STRAIN AT PEAK SHEAR STRESS
      EZ2 : STRAIN AT ZERO/FRACTURED STRESS
      STRAN(1) : DIRECT STRAIN
      STRAN(2): SHEAR STRAIN
      STRESS(1) : DIRECT STRESS
      STRESS(2) : SHEAR STRESS
      DDSDDE(I,J) : MATERIAL TANGENT STIFFNESS - DSTRESS(I)/DSTRAN(J)
      DAM : DAMAGE PARAMETER
```

-54-

APPENDIX TO SPECIFICATION PAGE 6 of 26

```
C
       IMPLICIT REAL*8(A-H,O-Z)
      PARAMETER (ONE=1.0, ZERO=0.0)
      DIMENSION STPESS(NTENS), STATEV(NSTATV),
     1 DDSDDE(NTENS,NTENS),
     3 STRAN(NTENS),
     4 PROPS (NPROPS)
C
         - PROPS(1)
      E2 = PROPS(2)
      EP1 = PROPS(3)
      EP2 - PROPS(4)
      EZ1 = PROPS(5)
      EZ2 = PROPS(6)
      DAM = STATEV(1)
C
      DO 10 I=1,NTENS
      STRESS(I)=ZERO
      DO 10 J-1, NTENS
   10 DDSDDE(I,J)=ZERO
C
      SIGP1 - E1*EP1
      SIGP2 - E2*EP2
      EPZ1 - EZ1 - EP1
      EPZ2 = EZ2 - EP2
      SOFT1 - -SIGP1/EPZ1
      SOFT2 - -SIGP2/EPZ2
CCC
      DETERMINE CURRENT DAMAGE
      DAM1 = (STRAN(1)-EP1)/EPZ1
DAM2 = (DABS(STRAN(2))-EP2)/EPZ2
      IF (DAMI.GE.DAM2) THEN
         JACT - 1
         DAMACT - DAM1
      ELSE
         JACT - 2
         DAMACT - DAM2
      IF (DAM.LT.DAMACT) THEN
         DAM - DAMACT
          STATEV(1) - DAM
      ELSE
         JACT = 0
      ENDIF
      STATEV(2) - FLOAT(JACT)
CCC
      IF COMPLETELY DAMAGED, WE'RE DONE
      IF (DAM.LT.ONE) THEN
C
         CALCULATE CURRENT PEAK STRAIN AND CURRENT STIFFNESSES AND FORCES
         EP1N = EP1 + DAM*EPZ1
         EP2N = EP2 + DAM \times EPZ2
         S1 = SIGP1*(ONE-DAM)/EP1N
```

-55-

```
APPENDIX TO SPECIFICATION PAGE 7 of 26
```

```
= SIGP2*(ONE-DAM)/EP2N
         STRESS(1) = S1*STRAN(1)
         STRESS(2) = S2*STRAN(2)
         CALCULATE TANGENT STIFFNESSES
C
         IF (JACT.EQ.0) THEN
C
            NO DAMAGING
            DDSDDE(1,1) = S1
            DDSDDE(2,2) = S2
         ELSEIF (JACT.EQ.1) THEN
            DAMAGING IN TENSION ONLY
            DDSDDE(1,1) - SOFT1
            DDSDDE(2,2) = S2
            DDSDDE(2,1) = -SIGP2*EZ2*STRAN(2)/(EP2N*EP2N*EPZ1)
         ELSE
C
            DAMAGING IN SHEAR ONLY
            DDSDDE(1,1) - S1
            DDSDDE(2,2) = SOFT2
            DDSDDE(1,2) = -SIGP1*EZ1*STRAN(1)
                         /(EP1N*EP1N*DSIGN(EPZ2,STRAN(2)))
         ENDIF
      ENDIF
      IF (STRAN(1).LE.ZERO) THEN
         DDSDDE(1,1) - E1
         STRESS(1) = E1*STRAN(1)
      ENDIF
C
      RETURN
      END
** STEP 1 : RAKE TOOL 10.0 DEG FROM VERTICAL
*STEP, NIGEOM, INC-10, CYC-10, SUBMAX, AMPLITUDE-STEP, MONOTONIC
*COUPLED TEMPERATURE-DISPLACEMENT, PTOL-150.0, TEMTOL-3.0, DELITMX-500.0
1.0E-3, 1.0E-3, 1.0E-5
*BOUNDARY
TOOL,
        6,, 0.174533
CENTER, 6,, 0.0
*NODE PRINT, FREQ=0
*EL PRINT, FREQ=0
** *NODE PRINT, FREQ-1, NSET-TOOL
** RF
** *ENERGY PRINT
** *PRINT, CONTACT=YES, DEFORMATION=YES
** *NODE PRINT, FREQ=5, NSET=BOT
** *EL PRINT, ELSET=INTER, FREQ=5
** S,E
** *NODE PRINT, FREQ=5
** NT
** *PLOT, FREQ=5
** *DETAIL, ELSET=MODEL
** *DISPLACED
** U, 1.0, 1
*END STEP
```

And a me men and a se o les . Cer à des me mente

-56

APPENDIX TO SPECIFICATION PAGE 8 of 26

```
** STEP 2 : INITIAL FRICTIONLESS MOVEMENT
*STEP, NLGEOM, INC-1000, CYC-10, SUBMAX, AMPLITUDE-RAMP, MONOTONIC
*COUPLED TEMPERATURE-DISPLACEMENT, PTOL-750.0, TEMTOL-3.0, DELTMX-500.0
0.5E-6, 0.5E-3, 0.5E-8
*ROUNDARY
CENTER, 6,, 0.00875
*NODE PRINT, FREQ-0
*EL PRINT, FREQ=0
** *NODE PRINT, FREQ=20, NSET=TOOL
** RF
** *ENERGY PRINT
** *PRINT, CONTACT-YES, DEFORMATION-YES
** *NODE PRINT, FREQ=20, NSET=BOT
** 11
** *EL PRINT, ELSET-INTER, FREQ-20
** S,E
** *EL PRINT, ELSET-ZOND, FREQ-20
** SDV
** *NODE PRINT, FREQ=20
** NT
** *PLOT, FREQ=20
** *DETAIL, ELSET-MODEL
** *DISPLACED
** U, 1.0, 1
* ZND STEP
*********** here's chip4rl.inp **************
** *HEADING, UNSYMM
** RATE INDEP, 10 DEGREE RAKE (FROM VERTICAL)
** SPEED = 1.75 M/S, WITH FRICTION, GRADED MESH
** USER ELEMENT FOR AUTO RELEASE - DEBONDING ELEMENT
** **WAVEFRONT MINIMIZATION, SUPPRESS
** *RESTART, READ, STEP=2, INC=52, WRITE, FREQ=50
** **
** *USER SUBROUTINE
          SUBROUTINE UEL(RHS, AMATRX, SVARS, ENERGY, JLINES, XVAL, NDOFEL, NRHS,
**
         1 NSVARS, PROPS, NPROPS, COORDS, MCRD, NNODE, U, DU, V, A, JTYPE, TIME, DTIME
**
**
         2 KSTEP, KINC, JELEM, PARAMS, NDLOAD, JDLTYP, ADLMAG, PREDEF, NPRED, LFLAGS)
          THIS ROUTINE BELONGS IN MAIN
                                                                           LAST UPDATE
** C
**
          THIS ROUTINE DEALS WITH A 4-NODED DEBONDING ELEMENT. THE INITIAL BOND IS BETWEEN NODES 1 AND 2. NODES 3 AND 4 ON THE 'MASTER' SURFACE ARE
**
   C
**
          USED ONLY FOR CALCULATING A SURFACE AREA. IT CALLS SUBROUTINE BOND
** C
          TO PROVIDE THE STRESSES AND MATERIAL TANGENT STIFFNESSES FOR THE
**
          BONDING MATERIAL.
** C
**
          IMPLICIT REAL*8(A-H,O-Z)
          PARAMETER (ONE-1.0, ZERO-0.0, NTENS-2, LU-50)
DIMENSION RHS(NDOFEL,NRHS), AMATRX(NDOFEL,NDOFEL), SVARS(1),
**
**
         1 ENERGY(6), JLINES(1), XVAL(1), PROPS(1), COORDS(MCRD, NNODE)
* *
         2 U(NDOFEL), DU(NDOFEL), V(NDOFEL), A(NDOFEL), TIME(7), DTIME(7),
**
         3 PARAMS(1), JDLTYP(NDLOAD, NRHS), ADLMAG(NDLOAD, NRHS, 2),
* *
         4 PREDEF(NPRED, NNODE, 2), LFLAGS(4)
**
         E ,STRESS(NTENS),DDSDDE(NTENS,NTENS),STRAN(NTENS)
          COMMON/CLINES/VERSN, DAT(2), TIM, NLPAGE, KLINE, KPAGE, JINP, JOUTP
```

Kit the Comment some

-57-

APPENDIX TO SPECIFICATION PAGE 9 of 26

```
INCLUDE 'ABQ47:[ABQ7.CMN1]CONSTS.CMN/LIST'
** C
** C
           SAVE KOUNT, INCOLD
           DATA KOUNT/0/ INCOLD/1/
           KOUNT - KOUNT + 1
** C
**
  C
           IF (KOUNT.EQ.1) THEN
** C
               OPEN(UNIT-LU, FILE-'TEST. DBG', STATUS-'NEW')
**
           ENDIF
** C
           IF (KINC.NE.INCOLD) WRITE(LU,*) ' '
** C
           INCOLD - KINC
** C
           WRITE(LU, 100) KSTEP, KINC, JELEM, KOUNT
       KINC - ',15,
KOUNT - ',16)
** C
** C
           WRITE(LU,*) 'U'
WRITE(LU,*) (U(I),I=1,NDOFEL)
** C
** C
**
**
          DO 20 JDOFEL-1, NDOFEL
**
          RHS(JDOFEL,1) - ZERO
**
          DO 20 IDOFEL-1, NDOFEL
**
       20 AMATRX(IDOFEL, JDOFEL) - ZERO
** C
**
          DAM = SVARS(1)
**
          IF (DAM.GE.ONE) RETURN
          THICK - PROPS(7)
**
**
          ALPHA = 0.5
** C
** C
          COMPUTE ELEMENT AREA/LENGTH
** C
**
          X2 - COORDS(1,2)
**
          Y2 = COORDS(2,2)
          X3 - COORDS(1,3)

Y3 - COORDS(2,3)
**
**
          X4 - COORDS(1,4)
**
**
          Y4 = COORDS(2,4)
          ALEN23 = DSQRT((X3-X2)*(X3-X2) + (Y3-Y2)*(Y3-Y2))

ALEN24 = DSQRT((X4-X2)*(X4-X2) + (Y4-Y2)*(Y4-Y2))
**
**
          ALEN = (ONE-ALPHA) *ALEN23 + ALPHA*ALEN24
**
** C
** C
          COMPUTE STRAINS
** C
          STRAN(1) = (U(4) - U(2))/THICK
STRAN(2) = (U(3) - U(1))/THICK
**
**
          COMPUTE STRESSES AND MATERIAL TANGENT STIFFS AND UPDATE DAMAGE
**
**
          CALL BOND(STRESS, SVARS, DDSDDE,
**
                      STRAN,
**
                      NDI, NSHR, NTENS, NSVARS, PROPS, NPROPS)
** C
**
          XNN = DDSDDE(1,1)*ALEN/THICK
          XNS = DDSDDE(1,2)*ALEN/THICK
XSN = DDSDDE(2,1)*ALEN/THICK
**
**
**
          XSS = DDSDDE(2,2)*ALEN/THICK
**
              = STRESS(1)*ALEN
          FN
           FS = STRESS(2)*ALEN
WRITE(LU,*) 'XNN, XNS, XSN, XSS, FN, FS'
**
          FS
** C
```

Col E turb the way broken a merchan the heart mercani

-58-

APPENDIX TO SPECIFICATION PAGE 10 of 26

```
WRITE(LU,*) XNN, XNS, XSN, XSS, FN, FS
** C
  C
** C
          STIFFNESS MATRIX
          AMATRX(1,1) = XSS
**
          AMATRX(1,2) - XSN
          AMATRX(1,3) = -AMATRX(1,1)
**
          AMATRX(1,4) = -AMATRX(1,2)

AMATRX(2,1) = XNS
**
**
**
          AMATRX(2,2) = XNN
          AMATRX(2,3) = -AMATRX(2,1)
**
**
          AMATRX(2,4) = -AMATRX(2,2)
          AMATRX(3,1) = -AMATRX(1,1)
**
**
          AMATRX(3,2) = -AMATRX(1,2)
          AMATRX(3,3) - AMATRX(1,1)
AMATRX(3,4) - AMATRX(1,2)
**
**
          AMATRX(4,1) = -AMATRX(2,1)
**
          AMATRX(4,2) = -AMATRX(2,2)

AMATRX(4,3) = AMATRX(2,1)

AMATRX(4,4) = AMATRX(2,2)
**
**
**
** C
          RESIDUAL CONTRIBUTION
** C
** C
**
          RHS(1,1) = FS
**
          RHS(2,1) = FN
          RHS(3,1) = -RHS(1,1)
**
          RHS(4,1) = -RHS(2,1)
**
** C
**
          RETURN
**
          END
** C
**
**
   C
          SUBROUTINE BOND (STRESS, STATEV, DDSDDE,
**
**
                             STRAN,
                             NDI, NSHR, NTENS, NSTATV, PROPS, NPROPS)
**
** C
**
          BONDING MATERIAL. THE BEHAVIOUR IS ELASTIC-FRACTURING IN
**
   C
          TENSION AND SHEAR AND ELASTIC IN COMPRESSION.
   č
**
**
   C
              : YOUNG'S MODULUS IN COMPRESSION AND INITIALLY IN TENSION
          EP1 : STRAIN AT PEAK COMPRESSIVE STRESS
   Č
**
**
   C
          EZ1 : STRAIN AT ZERO/FRACTURED STRESS
**
   C
               : SHEAR MODULUS
          E2
**
          EP2 : STRAIN AT PEAK SHEAR STRESS
**
   C
          EZ2 : STRAIN AT ZERO/FRACTURED STRESS
          STRAN(1): DIRECT STRAIN
STRAN(2): SHEAR STRAIN
**
**
   C
**
          STRESS(1) : DIRECT STRESS
**
   C
          STRESS(2) : SHEAR STRESS
          DDSDDE(I,J) : MATERIAL TANGENT STIFFNESS = DSTRESS(I)/DSTRAN(J)
**
          DAM : DAMAGE PARAMETER
   C
**
** C
          IMPLICIT REAL*8(A-H,O-Z)
**
          PARAMETER (ONE-1.0, ZERO-0.0)
**
          DIMENSION STRESS(NTENS), STATEV(NSTATV),
```

-59-

APPENDIX TO SPECIFICATION PAGE 11 of 26

```
1 DDSDDE(NTENS, NTENS),
**
         3 STRAN(NTENS),
         4 PROPS(NPROPS)
** C
          El - PROPS(1)
**
          E2 - PROPS(2)
          EP1 - PROPS(3)
**
          EP2 - PROPS(4)
**
**
          EZ1 - PROPS(5)
          EZ2 = PROPS(6)
**
**
          DAM - STATEV(1)
** C
**
          DO 10 I-1, NTENS
**
          STRESS(I)-ZERO
**
          DO 10 J-1, NTENS
**
      10 DDSDDE(I,J)=ZERO
** C
**
          SIGP1 - E1*EP1
**
          SIGP2 - E2*EP2
          EPZ1 = EZ1 - EP1
EPZ2 = EZ2 - EP2
**
**
          SOFT1 - -SIGP1/EPZ1
SOFT2 - -SIGP2/EPZ2
**
**
** C
** C
          DETERMINE CURRENT DAMAGE
** C
          DAM1 - (STRAN(1)-EP1)/EPZ1
DAM2 - (DABS(STRAN(2))-EP2)/EPZ2
**
**
          IF (DAM1.GE.DAM2) THEN
**
             JACT - 1
**
             DAMACT - DAM1
++
          ELSE
             JACT - 2
**
             DAMACT - DAM2
**
          ENDIF
          IF (DAM.LT.DAMACT) THEN
**
**
             DAM - DAMACT
**
             STATEV(1) - DAM
          ELSE
**
**
             JACT - 0
**
          ENDIF
**
          STATEV(2) - FLOAT(JACT)
** C
          IF COMPLETELY DAMAGED, WE'RE DONE
**
          IF (DAM.LT.ONE) THEN
** C
             CALCULATE CURRENT PEAK STRAIN AND CURRENT STIFFNESSES AND FORCES
** C
             EP1N = EP1 + DAM*EPZ1
             EP2N = EP2 + DAM*EPZ2
**
                  = SIGP1*(ONE-DAM)/EP1N
**
             Sl
                  - SIGP2*(ONE-DAM)/EP2N
             STRESS(1) = S1*STRAN(1)
STRESS(2) = S2*STRAN(2)
**
**
** C
```

-60-

APPENDIX TO SPECIFICATION PAGE 12 of 26

```
** C
             CALCULATE TANGENT STIFFNESSES
** C
**
             IF (JACT.EQ.0) THEN
** C
                NO DAMAGING
                DDSDDE(1,1) - S1
DDSDDE(2,2) - S2
**
**
**
             ELSEIF (JACT.EQ.1) THEN
** C
                DAMAGING IN TENSION ONLY
**
                DDSDDE(1,1) = SOFT1
**
                DDSDDE(2,2) = S2
**
                DDSDDE(2,1) = -SIGP2*EZ2*STRAN(2)/(EP2N*EP2N*EPZ1)
**
             ELSE
** C
                DAMAGING IN SHEAR ONLY
**
                DDSDDE(1,1) - S1
**
                DDSDDE(2,2) = SOFT2
**
                DDSDDE(1,2) = -SIGP1*EZ1*STRAN(1)
**
                              /(EP1N*EP1N*DSIGN(EPZ2,STRAN(2)))
**
             ENDIF
**
          ENDIF
**
          IF (STRAN(1).LE.ZERO) THEN
**
             DDSDDE(1,1) = E1
             STRESS(1) - E1*STRAN(1)
**
**
          ENDIF
** C
          RETURN
**
**
          END
**
** STEP 3 : CONTINUE WITH FRICTION / CHANGED FRICTION CONSTANTS
*STEP, NIGEOM, INC-800, CYC-10, SUBMAX, AMPLITUDE-RAMP, MONOTONIC
*COUPLED TEMPERATURE-DISPLACEMENT, PTOL-750.0, TEMTOL-3.0, DELTMX-500.0
1.0E-5, 5.5E-3, 1.0E-8 *CHANGE MATERIAL, ELSET-INTER
*FRICTION
   oneil put the friction at .50 !! ***
** ref: Iwata, Osakada et al, "process modeling ... rigid-plastic FEM" 0.5, 40.0E12, 400.0E6
*BOUNDARY
** TOTAL ANGULAR ADVANCE OF 6 DEG
CENTER, 6,, 0.104720
*NODE PRINT, FREQ-0
*EL PRINT, FREQ-0
** *NODE PRINT, FREQ=20, NSET=TOOL
** RF
** *ENERGY PRINT
** *PRINT, CONTACT=YES, DEFORMATION=YES
** *NODE PRINT, FREQ=150
** U
** *EL PRINT, ELSET=INTER, FREQ=20
** S,E
** *EL PRINT, ELSET=BOND, FREQ=20
** SDV
** *NODE PRINT, FREQ=20
** NT
** *PLOT, FREQ=20
** *DETAIL, ELSET=MODEL
```

-61-

APPENDIX TO SPECIFICATION PAGE 13 of 26

```
** *DISPLACED

** U, 1.0, 1

** ** some oneil output additions

*FILE FORMAT, ASCII

*NODE FILE, FREQ=100

U

NT

COORD

RF

*EL FILE, FREQ=100

S

SINV

PE

TEMP

** end of oneil output mods. ***

*END STEP
```

Contact the mental and a second

-62-

APPENDIX TO SPECIFICATION PAGE 14 of 26

```
*HEADING, UNSYMM
RATE INDEP, 10 DEGREE RAKE (FROM VERTICAL)
SPEED - 1.75 M/S, FRICTION-0.5, GRADED MESH
DEBONDING ELEMENT
**WAVEFRONT MINIMIZATION, SUPPRESS
** put restart at a freq. of 1000 to write only LAST iteration *RESTART, WRITE, FREQ-1000
** NODES
**
*NODE, SYSTEM-C
1, 0.10033, 90.000
1001, 0.10033, 90.000
9001, 0.10160, 89.945
*NSET, NSET-BL
1001
*NSET, NSET-TL
9001
*NFILL, BIAS=0.8, NSET=LHS
BL, TL, 8, 1000
*NSET, NSET-LHS, GEN
1, 9001, 1000
*NCOPY, OLD SET-LHS, CHANGE NUMBER-1, SHIFT, MULTIPLE-64, NEW SET-ALL
0., 0., 0.
0., 0., 0., 0.
*NSET, NSET-ALL
                0., 0., -1., 0.159
LHS
*NSET, NSET-BOT, GEN
1001, 1065, 1
*NODE, NSET-MASTER
50001, 0., 0.
*NCOPY, OLD SET-MASTER, CHANGE NUMBER=1, SHIFT, MULTIPLE=64
0., 0., 0.
0., 0., 0., 0., 0., -1.
*NSET, NSET-CENTER, GEN
50001, 50065, 1
*NODE, NSET-TOOL
               0., 0., -1., 0.0
60000, 0.0, 0.10033
** DEFINE ELEMENTS
**
**
      CHIP
*ELEMENT, TYPE=CPE4
1001, 1001, 1002, 2002, 2001
```

fire free winet one comme wit fimments

-63-

APPENDIX TO SPECIFICATION PAGE 15 of 26

```
*ELGEN, ELSET=CHIP
1001, 64, 1, 1, 8, 1000, 1000
*SOLID SECTION, ELSET-CHIP, MAT-ST4340
*MATERIAL, NAME-ST4340
*ELASTIC
209.0E9, 0.33
*PLASTIC
** this is the "CHIP8" stress - strain curve
 800.0E6, 0.00
 850.0E6, 0.10
 800.0E6, 0.25
750.0E6, 0.50
700.0E6, 1.00
 700.0E6, 1.25
700.0E6, 1.50
700.0E6, 2.00
***RATE DEPENDENT
** 40.0, 5.0
*SPECIFIC HEAT
**J/kg -K
599.13
*DENSITY
**kg/m**3
7700.0
*CONDUCTIVITY
**W/m-K
43.0
***EXPANSION
** /K
**21.6E-6
*INELASTIC HEAT FRACTION
1.0
**
**
       SPOKES
*ELEMENT, TYPE-B21, ELSET-SPOKE
50001, 50001, 1
*ELGEN, ELSET-SPOKE
50001, 65, 1, 1
*BEAM SECTION, MAT-SPOKE, ELSET-SPOKE, SECT-RECT
** WIDTH, DEPTH
1.0, 0.1
*MATERIAL, NAME=SPOKE
*ELASTIC
209.0E9, 0.33
**
**
       BONDS
**
*USER ELEMENT, TYPE-U1, NODES-4, COORDINATES-2, PROP-7, VAR-2, UNSYMM
*UEL PROPERTY, ELSET-BOND

** E1, E2, EP1, EP2, EZ1, EZ2, THICK

** WHERE THICK*EZ1 = 2*J1C/SIGY1,
                                                  THICK*EZ2 = 2*J2C/SIGY2
** AND SIGY2 = SIGY1/2 AND E2 = E1/(2*(1+NU))

** J1C = J2C = 87600 N-N/M**2 (= 500 IN-LBF/IN**2)

200.0E9, 75.2E9, 4.0E-3, 5.33E-3, 3.65, 7.30, 0.06E-3
```

Same and the second of the same

-64-

APPENDIX TO SPECIFICATION PAGE 16 of 26

```
*ELEMENT, TYPE=Ul, FLSET=BOND
 1, 1, 1001, 1001, 1002
2, 2, 1002, 1001, 1003
65, 65, 1065, 1064, 1065
*ELGEN, ELSET=BOND
2, 63, 1, 1
**
      TOOL-CHIP INTERFACES
*ELEMENT, TYPE=IRS21, ELSET=INTER
60001, 1001, 1002, 60000
61001, 1001, 2001, 60000
*ELGEN, ELSET-INTER
60001, 64, 1, 1
61001, 8, 1000, 1000
** DESIGN 5 INTERFACE ELEMENT DEFINITION (UNITS - METERS)
*RIGID SURFACE, TYPE-SEGMENTS, ELSET-INTER, SMOOTH-.0762E-03
** 1 MM HAS BEEN ADDED TO ALL 'Y' VALUES
START, 0.0, 107.33E-03
LINE, 0.0, 102.91318E-03
LINE,
       -.46228E-03, 102.332E-03
-.46228E-03, 101.6E-03
LINE, -.46228E-03, _
LINE, 0.0, 100.33E-03
LINE, 0.0, 99.33E-03
*INTERFACE, ELSET=INTER
*FRICTION
0.0, 1.0E12
*BOUNDARY
TOOL, 1, 2,
CENTER, 1, 2, 0.0
*INITIAL CONDITIONS, TYPE=TEMP
ALL, 0.0
*ELSET, ELSET-MODEL
CHIP, INTER
***PLOT
***DETAIL, ELSET-MODEL
***DRAW
*USER SUBROUTINE
       SUBROUTINE UEL(RHS, AMATRX, SVARS, ENERGY, JLINES, XVAL, NDOFEL, NRHS,
      1 NSVARS, PROPS, NPROPS, COORDS, MCRD, NNODE, U, DU, V, A, JTYPE, TIME, DTIME
      2 KSTEP, KINC, JELEM, PARAMS, NDLOAD, JDLTYP, ADLMAG, PREDEF, NPRED, LFLAGS)
       THIS ROUTINE BELONGS IN MAIN
                                                                      LAST UPDATE
0000000
       THIS ROUTINE DEALS WITH A 4-NODED DEBONDING ELEMENT. THE INITIAL BOND
       IS BETWEEN NODES 1 AND 2. NODES 3 AND 4 ON THE 'MASTER' SURFACE ARE
       USED ONLY FOR CALCULATING A SURFACE AREA. IT CALLS SUBROUTINE BOND
       TO PROVIDE THE STRESSES AND MATERIAL TANGENT STIFFNESSES FOR THE
       BONDING MATERIAL.
       IMPLICIT REAL*8(A-H,O-Z)
                                                                                 •
       PARAMETER (ONE-1.0, ZERO-0.0, NTENS-2, LU-50)
       DIMENSION RHS(NDOFEL, NRHS), AMATRX(NDOFEL), NDOFEL), SVARS(1),
```

-65-

APPENDIX TO SPECIFICATION PAGE 17 of 26

```
1 ENERGY(6), JLINES(1), XVAL(1), PROPS(1), COORDS(MCRD, NNODE),
     2 U(NDOFEL), DU(NDOFEL), V(NDOFEL), A(NDOFEL), TIME(7), DTIME(7),
     3 PARAMS(1), JDLTYP(NDLOAD, NRHS), ADLMAG(NDLOAD, NRHS, 2),
     4 PREDEF(NPRED, NNODL, 2), LFLAGS(4)
     E , STRESS(NTENS), DDSDDE(NTENS, NTENS), STRAN(NTENS)
      COMMON/CLINES/VERSN, DAT(2), TIM, NLPAGE, KLINE, KPAGE, JINP, JOUTP
C
      INCLUDE 'ABO47: [ABO7.CMN1] CONSTS.CMN/LIST'
       SAVE KOUNT, INCOLD
CCCC
       DATA KOUNT/0/ INCOLD/1/
       KOUNT = KOUNT + 1
       IF (KOUNT.EQ.1) THEN
C
          OPEN(UNIT-LU, FILE-'TEST.DBG', STATUS-'NEW')
       ENDIF
       IF (KINC.NE.INCOLD) WRITE(LU,*) ' '
C
       INCOLD - KINC
       WRITE(LU, 100) KSTEP, KINC, JELEM, KOUNT
CC
   Ċ
       WRITE(LU,*) 'U'
C
       WRITE(LU, *) (U(I), I=1, NDOFEL)
      DO 20 JDOFEL-1, NDOFEL
      RHS(JDOFEL,1) - ZERO
      DO 20 IDOFEL-1, NDOFEL
   20 AMATRX(IDOFEL, JDOFEL) - ZERO
      DAM = SVARS(1)
      IF (DAM.GE.ONE) RETURN
      THICK - PROPS(7)
      ALPHA = 0.5
Ç
      COMPUTE ELEMENT AREA/LENGTH
      X2 = COORDS(1,2)
      Y2 = COORDS(2,2)
      X3 = COORDS(1,3)
      Y3 = COORDS(2,3)
      X4 = COORDS(1,4)
      Y4 = COORDS(2,4)
      ALEN23 = DSQRT((X3-X2)*(X3-X2) + (Y3-Y2)*(Y3-Y2))
      ALEN24 = DSQRT((X4-X2)*(X4-X2) + (Y4-Y2)*(Y4-Y2))
      ALEN = (ONE-ALPHA)*ALEN23 + ALPHA*ALEN24
C
С
      COM 'UTE STRAINS
C
      STRAN(1) = (U(4) - U(2))/THICK
STRAN(2) = (U(3) - U(1))/THICK
C
      COMPUTE STRESSES AND MATERIAL TANGENT STIFFS AND UPDATE DAMAGE
      CALL BOND(STRESS, SVARS, DDSDDE,
     2
                 STRAN,
                 NDI, NSHR, NTENS, NSVARS, PROPS, NPROPS)
C
      XNN = DD>DDE(1,1) *ALEN/THICK
```

es el manuel mes de la companya de l

-66-

APPENDIX TO SPECIFICATION PAGE 18 of 26

```
XNS = DDSDDE(1,2)*ALEN/THICK
       XSN = DDSDDE(2,1)*ALEN/THICK
       XSS = DDSDDE(2,2) *ALEN/THICK
       FN = STRESS(1) *ALEN
       FS = STRESS(2)*ALEN
WRITE(LU,*) 'XNN, XNS, XSN, XSS, FN, FS'
WRITE(LU,*) XNN, XNS, XSN, XSS, FN, FS
00000
       STIFFNESS MATRIX
       AMATRX(1,1) = XSS
       AMATRX(1,2) = XSN
       AMATRX(1,3) = -AMATRX(1,1)
       AMATRX(1,4) = -AMATRX(1,2)
AMATRX(2,1) = XNS
       AMATRX(2,2) - XNN
       AMATRX(2,3) = -AMATRX(2,1)
       AMATRX(2,4) = -AMATRX(2,2)
AMATRX(3,1) = -AMATRX(1,1)
       AMATRX(3,2) = -AMATRX(1,2)
       AMATRX(3,3) - AMATRX(1,1)
AMATRX(3,4) - AMATRX(1,2)
       AMATRX(4,1) = -AMATRX(2,1)
       AMATRX(4,2) = -AMATRX(2,2)

AMATRX(4,3) = AMATRX(2,1)

AMATRX(4,4) = AMATRX(2,2)
C
       RESIDUAL CONTRIBUTION
       RHS(1,1) = FS
       RHS(2,1) = FN
       RHS(3,1) = -RHS(1,1)
       RHS(4,1) = -RHS(2,1)
C
       RETURN
       END
C
C
       SUBROUTINE BOND (STRESS, STATEV, DDSDDE,
                            STRAN,
                            NDI, NSHR, NTENS, NSTATV, PROPS, NPROPS)
       BONDING MATERIAL. THE BEHAVIOUR IS ELASTIC-FRACTURING IN
C
        TENSION AND SHEAR AND ELASTIC IN COMPRESSION.
C
       El : YOUNG'S MODULUS IN COMPRESSION AND INITIALLY IN TENSION EP1 : STRAIN AT PEAK COMPRESSIVE STRESS
C
C
       EZ1 : STRAIN AT ZERO/FRACTURED STRESS
CC
       E2 : SHEAR MODULUS
       EP2 : STRAIN AT PEAK SHEAR STRESS
       EZ2 : STRAIN AT ZERO/FRACTURED STRESS STRAN(1) : DIRECT STRAIN
С
C
C
       STRAN(2) : SHEAR STRAIN
       STRESS(1) : DIRECT STRESS
       STRESS(2) : SHEAR STRESS
```

-67-

APPENDIX TO SPECIFICATION PAGE 19 of 26

```
DDSDDE(I,J) : MATERIAL TANGENT STIFFNESS = DSTRESS(I)/DSTRAN(J)
С
       DAM : DAMAGE PARAMETER
       IMPLICIT REAL*8(A-H,O-Z)
       PARAMETER (ONE-1.0, ZERO-0.0)
DIMENSION STRESS(NTENS), STATEV(NSTATV),
      1 DDSDDE(NTENS, NTENS),
      3 STRAN(NTENS)
      4 PROPS (NPROPS)
C
       E1 = PROPS(1)
E2 = PROPS(2)
       EP1 - PROPS(3)
       EP2 = PROPS(4)
       EZ1 - PROPS(5)
       EZ2 - PROPS(6)
       DAM - STATEV(1)
C
       DO 1.0 I-1, NTENS
       STRESS(I)=ZERO
       DO 10 J-1,NTENS
   10 DDSDDE(I,J)~ZERO
C
       SIGP1 - E1*EP1
       SIGP2 - E2*EP2
       EPZ1 - EZ1 - EP1
EPZ2 - EZ2 - EP2
       SOFT1 - -SIGP1/EPZ1
       SOFT2 - -SIGP2/EPZ2
CCC
       DETERMINE CURRENT DAMAGE
       DAM1 - (STRAN(1)-EP1)/EPZ1
DAM2 - (DABS(STRAN(2))-EP2)/EPZ2
       IF (DAM1.GE.DAM2) THEN
          JACT - 1
          DAMACT - DAMI
       ELSE
          JACT - 2
          DAMACT - DAM2
       ENDIF
       IF (DAM.LT.DAMACT) THEN
          DAM - DAMACT
          STATEV(1) - DAM
       ELSE
          JACT - 0
       ENDIF
       STATEV(2) - FLOAT(JACT)
CC
       IF COMPLETELY DAMAGED, WE'RE DONE
       IF (DAM.LT.ONE) THEN
CCC
          CALCULATE CURRENT PEAK STRAIN AND CURRENT STIFFNESSES AND FORCES
          EP1N = EP1 - DAM*EPZ1
```

-68-

APPENDIX TO SPECIFICATION PAGE 20 of 26

```
EP2N - EP2 + DAM*EPZ2
             = SIGP1*(ONE-DAM)/EP1N
         S1
              = SIGP2*(ONE-DAM)/EP2N
         STRESS(1) = S1*STRAN(1)
         STRESS(2) = S2*STRAN(2)
C
C
         CALCULATE TANGENT STIFFNESSES
Ċ
         IF (JACT.EQ.0) THEN
            NO DAMAGING
C
             DDSDDE(1,1) = S1
            DDSDDE(2,2) - S2
         ELSEIF (JACT.EQ.1) THEN
            DAMAGING IN TENSION ONLY
C
            DDSDDE(1,1) - SOFT1
            DDSDDE(2,2) = S2
            DDSDDE(2,1) = -SIGP2*EZ2*STRAN(2)/(EP2N*EP2N*EPZ1)
         ELSE
C
            DAMAGING IN SHEAR ONLY
            DDSDDE(1,1) - S1
            DDSDDE(2,2) = SOFT2
            DDSDDE(1,2) - -SIGP1*EZ1*STRAN(1)
                         /(EPIN*EPIN*DSIGN(EPZ2,STRAN(2)))
     1
         ENDIF
      ENDIF
      IF (STRAN(1).LE.ZERO) THEN
         DDSDDE(1,1) - E1
STRESS(1) - E1*STRAN(1)
      ENDIF
C
      RETURN
      END
** STEP 1 : RAKE TOOL 10.0 DEG FROM VERTICAL
*STEP, NLGEOM, INC=10, CYC=10, SUBMAX, AMPLITUDE-STEP, MONOTONIC
*COUPLED TEMPERATURE-DISPLACEMENT, PTOL-150.0, TEMTOL-3.0, DELITMX-500.0
1.0E-3, 1.0E-3, 1.0E-5
*BOUNDARY
TOOL,
        6,, 0.174533
CENTER, 6,, 0.0
*NODE PRINT, FREQ=0
*EL PRINT, FREQ=0
** *NODE PRINT, FREQ-1, NSET-TOOL
** RF
** *ENERGY PRINT
** *PRINT, CONTACT=YES, DEFORMATION=YES
** *NODE PRINT, FREQ=5, NSET=BOT
** U
** *EL PRINT, ELSET=INTER, FREQ=5
** S,E
** *NODE PRINT, FREQ=5
** NT
** *PLOT, FREQ=5
** *DETAIL, ELSET=MODEL
** *DISPLACED
```

-69-

APPENDIX TO SPECIFICATION PAGE 21 of 26

```
** U, 1.0, 1
 *END STEP
 ** STEP 2 : INITIAL FRICTIONLESS MOVEMENT
 *STEP, NLGEOM, INC-1000, CYC-10, SUBMAX, AMPLITUDE-RAMP, MONOTONIC
 *COUPLED TEMPERATURE-DISPLACEMENT, PTOL-750.0, TEMTOL-3.0, DELTMX-500.0
 0.5E-6, 0.5E-3, 0.5E-8
 *BOUNDARY
 CENTER, 6,, 0.00875
 *NODE PRINT, FREQ-0
 *EL PRINT, FREQ=0
 ** *NODE PRINT, FREQ=20, NSET=TOOL
 ** RF
 ** *ENERGY PRINT
 ** *PRINT, CONTACT=YES, DEFORMATION=YES
 ** *NODE PRINT, FREQ=20, NSET=BOT
** U
** *EL PRINT, ELSET-INTER, FREO-20
 ** S,E
 ** *EL PRINT, ELSET-BOND, FREQ-20
 ** SDV
 ** *NODE PRINT, FREQ=20
** NT
 ** *PLOT, FREQ=20
 ** *DETAIL, ELSET-MODEL
 ** *DISPLACED
 ** U, 1.0, 1
 *END STEP
 ******** here's chip4rl.inp *************
 ** *HEADING, UNSYMM
** RATE INDEP, 10 DEGREE RAKE (FROM VERTICAL)

** SPEED = 1.75 M/S, WITH FRICTION, GRADED MESH

** USER ELEMENT FOR AUTO RELEASE - DEBONDING ELEMENT
 ** **WAVEFRONT MINIMIZATION, SUPPRESS
 ** *RESTART, READ, STEP=2, INC=52, WRITE, FREQ=50
 ** **
 ** *USER SUBROUTINE
           SUBROUTINE UEL(RHS, AMATRX, SVARS, ENERGY, JLINES, XVAL, NDOFEL, NRHS,
 **
 **
          1 NSVARS, PROPS, NPROPS, COORDS, MCRD, NNODE, U, DU, V, A, JTYPE, TIME, DTIME
 **
          2 KSTEP, KINC, JELEM, PARAMS, NDLOAD, JDLTYP, ADLMAG, PREDEF, NPRED, LFLAGS)
            THIS ROUTINE BELONGS IN MAIN
                                                                             LAST UPDATE
 **
 **
            THIS ROUTINE DEALS WITH A 4-NODED DEBONDING ELEMENT. THE INITIAL BOND
           IS BETWEEN NODES 1 AND 2. NODES 3 AND 4 ON THE 'MASTER' SURFACE ARE USED ONLY FOR CALCULATING A SURFACE AREA. IT CALLS SUBROUTINE BOND
 **
    C
 **
    C
 **
           TO PROVIDE THE STRESSES AND MATERIAL TANGENT STIFFNESSES FOR THE
           BONDING MATERIAL.
 **
 ** C
           IMPLICIT REAL*8(A-H,O-Z)
 **
           PARAMETER (ONE=1.0, ZERO=0.0, NTENS=2, LU=50)
DIMENSION RHS(NDOFEL, NRHS), AMATRX(NDOFEL, NDOFEL), SVARS(1),
 **
          1 ENERGY(6), JLINES(1), XVAL(1), PROPS(1), COORDS(MCRD, NNODE),
 **
          2 U(NDOFEL), DU(NDOFEL), V(NDOFEL), A(NDOFEL), TIME(7), DTIME(7)
3 PARAMS(1), JDLTYP(NDLOAD, NRHS), ADLMAG(NDLOAD, NRHS, 2),
 **
 **
          4 PREDEF (NPRED, NNODE, 2), LFLAGS(4)
```

-70-

APPENDIX TO SPECIFICATION PAGE 22 of 26

```
E ,STRESS(NTENS),DDSDDE(NTENS,NTENS),STRAN(NTENS)
          COMMON/CLINES/VERSN, DAT(2), TIM, NLPAGE, KLINE, KPAGE, JINP, JOUTP
** C
          INCLUDE 'ABQ47:[ABQ7.CMN1]CONSTS.CMN/LIST'
** C
** C
** C
           SAVE KOUNT, INCOLD
** C
           DATA KOUNT/0/ INCOLD/1/
           KOUNT - KOUNT + 1
** C
** C
           IF (KOUNT.EQ.1) THEN
** C
              OPEN(UNIT LU, FILE='TEST. DBG', STATUS='NEW')
** C
           ENDIF
** C
           IF (KINC.NE.INCOLD) WRITE(LU,*) ' '
** C
           INCOLD - KINC
      ** C
                                      KINC = ',15,
KOUNT = ',16)
** C
** C
           WRITE(LU, *) 'U'
** C
           WRITE(LU,*) (U(I),I=1,NDOFEL)
** C
** C
          DO 20 JDOFEL-1, NDOFEL
**
          RHS(JDOFEL,1) = ZERO
**
          DO 20 IDOFEL-1, NDOFEL
      20 AMATRX(IDOFEL, JDOFEL) = ZERO
**
** C
**
          DAM - SVARS(1)
          IF (DAM.GE.ONE) RETURN
**
          THICK - PROPS(7)
**
**
          ALPHA = 0.5
** C
          COMPUTE ELEMENT AREA/LENGTH
** C
         X2 = COORDS(1,2)
**
         Y2 - COORDS (2,2)
**
**
          X3 = COORDS(1,3)
         Y3 - COORDS(2,3)
**
**
          X4 = COORDS(1,4)
          Y4 = COORDS(2,4)
**
         ALEN23 = DSQRT((X3-X2)*(X3-X2) + (Y3-Y2)*(Y3-Y2))
ALEN24 = DSQRT((X4-X2)*(X4-X2) + (Y4-Y2)*(Y4-Y2))
**
**
          ALEN = (ONE-ALPHA) *ALEN23 + ALPHA*ALEN24
** C
          COMPUTE STRAINS
** C
**
          STRAN(1) = (U(4) - U(2))/THICK
STRAN(2) = (U(3) - U(1))/THICK
** C
** C
          COMPUTE STRESSES AND MATERIAL TANGENT STIFFS AND UPDATE DAMAGE
** C
**
          CALL BOND(STRESS, SVARS, DDSDDE,
**
         2
                     STRAN,
**
                     NDI, NSHR, NTENS, NSVARS, PROPS, NPROPS)
** C
**
          XNN = DDSDDE(1,1) *ALEN/THICK
**
          XNS = DDSDDE(1,2)*ALEN/THICK
**
          XSN = DDSDDE(2,1)*ALEN/THICK
**
          XS9 = DDSDDE(2,2)*ALEN/THICK
          FN = STRESS(1) *ALEN
```

Ch tan miguibate a entaba Cillia linda

-71-

APPENDIX TO SPECIFICATION PAGE 23 of 26

```
FS = STRESS(2)*ALEN
WRITE(LU,*) 'XNN, XNS, XSN, XSS, FN, FS'
WRITE(LU,*) XNN, XNS, XSN, XSS, FN, FS
** C
**
   C
** C
           STIFFNESS MATRIX
** C
**
           AMATRX(1,1) = XSS
**
           AMATRX(1,2) = XSN
**
           AMATRX(1,3) = -AMATRX(1,1)
**
           AMATRX(1,4) = -AMATRX(1,2)
**
           AMATRX(2,1) - XNS
**
           AMATRX(2,2) = XNN
           AMATRX(2,3) = -AMATRX(2,1)

AMATRX(2,4) = -AMATRX(2,2)
**
**
           AMATRX(3,1) = -AMATRX(1,1)
           AMATRX(3,2) - -AMATRX(1,2)
AMATRX(3,3) - AMATRX(1,1)
**
**
**
           AMATRX(3,4) = AMATRX(1,2)
**
           AMATRX(4,1) = -AMATRX(2,1)
**
           AMATRX(4,2) = -AMATRX(2,2)
**
           AMATRX(4,3) = AMATRX(2,1)
**
           AMATRX(4,4) = AMATRX(2,2)
** C
**
   C
           RESIDUAL CONTRIBUTION
** C
**
           RHS(1,1) = FS
**
           RHS(2,1) = FN
**
           RHS(3.1) = -RHS(1.1)
**
           RHS(4,1) = -RHS(2,1)
** C
**
           RETURN
**
           END
** C
**
   C
**
   С
**
           SUBROUTINE BOND (STRESS, STATEV, DDSDDE,
**
                              STRAN,
**
                              NDI, NSHR, NTENS, NSTATV, PROPS, NPROPS)
   C
**
   CC
          BONDING MATERIAL. THE BEHAVIOUR IS ELASTIC-FRACTURING IN
**
           TENSION AND SHEAR AND ELASTIC IN COMPRESSION.
**
   C
          El : YOUNG'S MODULUS IN COMPRESSION AND INITIALLY IN TENSION EP1 : STRAIN AT PEAK COMPRESSIVE STRESS
   C
**
   C
           EZ1 : STRAIN AT ZERO/FRACTURED STRESS
**
   C
**
   C
               : SHEAR MODULUS
          E2
**
           EP2 : STRAIN AT PEAK SHEAR STRESS
          EZ2 : STRAIN AT ZERO/FRACTURED STRESS
STRAN(1) : DIRECT STRAIN
**
   Č
**
   C
**
   С
           STRAN(2) : SHEAR STRAIN
** C
           STRESS(1) : DIRECT STRESS
          STRESS(2): SHEAR STRESS
DDSDDE(I,J): MATERIAL TANGENT STIFFNESS - DSTRESS(I)/DSTRAN(J)
** C
   С
**
   C
          DAM : DAMAGE PARAMETER
##
   C
* *
           IMPLICIT REAL*8(A-H,O-Z)
```

propage and a contract to the contract and a second propage

-72-

APPENDIX TO SPECIFICATION PAGE 24 of 26

```
**
          PARAMETER (ONE=1.0, ZERO=0.0)
          DIMENSION STRESS(NTENS), STATEV(NSTATV),
**
         1 DDSDDE(NTENS, NTENS),
**
         3 STRAN(NTENS),
**
         4 PROPS(NPROPS)
** C
**
          E1
              - PROPS(1)
**
          E2 - PROPS(2)
**
          EP1 - PROPS(3)
          EP2 = PROPS(4)
**
**
          EZ1 - PROPS(5)
          EZ2 - PROPS(6)
**
**
          DAM - STATEV(1)
** C
**
          DO 10 I-1, NTENS
**
          STRESS(I)-ZERO
**
          DO 10 J-1, NTENS
       10 DDSDDE(I,J)=ZERO
** C
**
          SIGP1 - E1*EP1
**
          SIGP2 - E2*EP2
**
          EPZ1 - EZ1 - EP1
          EPZ2 - EZ2 - EP2
**
**
          SOFT1 - -SIGP1/EPZ1
**
          SOFT2 - -SIGP2/EPZ2
** C
** C
          DETERMINE CURRENT DAMAGE
** C
**
          DAM1 - (STRAN(1)-EP1)/EPZ1
DAM2 - (DABS(STRAN(2))-EP2)/EPZ2
          DAM1 -
**
**
          IF (DAMI.GE.DAM2) THEN
**
             JACT - 1
**
             DAMACT - DAM1
**
         ELSE
             JACT - 2
**
             DAMACT - DAM2
**
**
         ENDIF
**
          IF (DAM.LT.DAMACT) THEN
**
             DAM - DAMACT
**
             STATEV(1) - DAM
**
         ELSE
**
             JACT - 0
         ENDIF
**
          STATEV(2) = FLOAT(JACT)
** C
** C
         IF COMPLETELY DAMAGED, WE'RE DONE
** C
**
         IF (DAM.LT.ONE) THEN
** C
** C
             CALCULATE CURRENT PEAK STRAIN AND CURRENT STIFFNESSES AND FORCES
** C
**
             EP1N = EP1 - DAM*EPZ1
* *
             EP2N = EP2 + DAM*EPZ2
             S1 = SIGP1*(ONE-DAM)/EP1N
S2 = SIGP2*(ONE-DAM)/EP2N
* *
**
             STRESS(1) = S1*STRAN(1)
```

-73-

APPENDIX TO SPECIFICATION PAGE 25 of 26

```
STRESS(2) = S2*STRAN(2)
** C
  C
            CALCULATE TANGENT STIFFNESSES
** C
**
            IF (JACT.EQ.0) THEN
** C
               NO DAMAGING
               DDSDDE(1,1) = S1
**
               DDSDDE(2,2) = S2
            ELSEIF (JACT.EQ.1) THEN
** C
               DAMAGING IN TENSION ONLY
               DDSDDE(1,1) = SOFT1
**
               DDSDDE(2,2) = S2
**
               DDSDDE(2,1) = -SIGP2*EZ2*STRAN(2)/(EP2N*EP2N*EPZ1)
**
            ELSE
** C
               DAMAGING IN SHEAR ONLY
**
               DDSDDE(1,1) = S1
**
               DDSDDE(2,2) = SOFT2
**
               DDSDDE(1,2) = -SIGP1*EZ1*STRAN(1)
**
                           /(EP1N*EP1N*DSIGN(EPZ2,STRAN(2)))
**
            ENDIF
**
         ENDIF
**
         IF (STRAN(1).LE.ZERO) THEN
            DDSDDE(1,1)
                         - E1
**
            STRESS(1) = E1*STRAN(1)
         ENDIF
** C
**
         RETURN
**
         END
** STEP 3 : CONTINUE WITH FRICTION / CHANGED FRICTION CONSTANTS
*STEP, NLGEOM, INC-800, CYC-10, SUBMAX, AMPLITUDE-RAMP, MONOTONIC
*COUPLED TEMPERATURE-DISPLACEMENT, PTOL-750.0, TEMTOL-3.0, DELIMX-500.0
1.0E-5, 5.5E-3, 1.0E-8
*CHANGE MATERIAL, ELSET-INTER
*FRICTION
  oneil put the friction at .50 !! ***
** ref: Iwata, Osakada et al, "process modeling ... rigid-plastic FEM"
0.1, 40.0E12, 400.0E6
*BOUNDARY
** TOTAL ANGULAR ADVANCE OF 6 DEG
CENTER, 6,, 0.104720
*NODE PRINT, FREQ=0
*EL PRINT, FREQ=0
** *NODE PRINT, FREQ=20, NSET=TOOL
** RF
** *ENERGY PRINT
** *PRINT, CONTACT=YES, DEFORMATION=YES
** *NODE PRINT, FREQ=150
** U
** *EL PRINT, ELSET=INTER, FREQ=20
** S,E
** *EL PRINT, ELSET=BOND, FREC=20
** SDV
** *NODE PRINT, FREQ=20
** NT
```

-74-

APPENDIX TO SPECIFICATION PAGE 26 of 26

```
** *PLOT, FREQ-20

** *DETAIL, ELSET-MODEL

** *DISPLACED

** U, 1.0, 1

** ** SOC.2 Oneil output additions

*FILE FORMAT, ASCII

*NODE FILE, FREQ-100

U

NT

COORD

RF

*EL FILE, FREQ-100

S

SINV

PE

TEMP

** end of oneil output mods. ***

*END STEP
```

THE CLAIMS DEFINING THE INVENTION ARE AS FOLLOWS:

- 1. A method of designing a cutting tool comprising the steps of:
- (a) providing a modifiable finite element tool model for predicting tool response during a cutting operation on a workpiece, wherein said tool model includes a tool input vector with at least one adjustable tool parameter;
 - (b) providing a modifiable finite element chip-flow model for simulating chip-flow during said cutting operation, wherein said chip-flow model includes a chip-flow input vector with at least one adjustable chip-flow parameter;
 - (c) executing said tool model to derive the prediction of said tool response;
 - (d) executing said chip-flow model to derive the simulation of said chip-flow;
 - (c) evaluating said predicted tool response and said simulated chip-flow with an artificial intelligence means including an adaptive set of rules for determining a correlation between said predicted tool response and said simulated chip-flow and acceptability criterion;
 - (f) providing recommendations with said artificial intelligence means based on said correlation;
- (g) altering at least one of said modifiable tool parameters, said modifiable chip-flow parameters, and said adaptive rules with said artificial intelligence means based on said recommendations; and
 - (h) repeating steps (a) through (g) until an acceptable correlation corresponding to an optimal tool design is achieved.
- 25 2. The method of designing a cutting tool of claim 1 wherein said artificial intelligence means accesses a database including data related to past predicted rool responses and past simulated chip-flows.
- 3. The method of designing a cutting tool of claim 1 wherein said tool model
 30 mathematically relates said input vector of tool parameters to an output vector of
 performance indices together constituting said predicted tool response; and

wherein said chip-flow model mathematically relates said input vector of



chip-flow parameters to an output vector of performance indices together constituting said chip-flow simulation.

- 4. The method of designing a cutting tool of claim 1 further including the step of:
 5 manufacturing a cutting tool based on said optimal tool design.
 - 5. The method of designing a cutting tool of claim 1 wherein the step of executing said chip-flow simulation includes the step of:

performing an explicit time integration analysis.

10

- 6. The method of designing a cutting tool of claim 1 wherein the step of executing said chip-flow simulation includes the step of:
 - performing an implicit time integration analysis.
- 15 7. The method of designing a cutting tool of claim 1 further including the step of: storing the predicted tool response of said tool model and the simulation of said chip-flow from said chip-flow model in said data base.
- 8. The method of designing a cutting tool of claim 1 further including the step of:
 20 interactively viewing an animated rendering of said cutting operation and
 concurrently monitoring performance indices of said predicted tool response and said
 chip-flow simulation.
- 9. The method of designing a cutting tool of claim 1 further including the step of:
 25 producing line drawings of said tool for visual inspection using computer-aided designing prior to constructing said tool model and said chip-flow model.
 - 10. The method of designing a cutting tool of claim 1 further comprising the step of: constructing a cutting tool based on said optimal tool design in a computer-aided manufacturing operation.
 - 11. The method of designing a cutting tool of claim 1 further including the steps of:

producing a punch and die combination in accordance with said optimal tool design;

pressing a powder material to form a green body using said punch and die combination;

- densifying said green body; and grinding and coating said densified green body to produce said cutting tool.
- 12. The method of designing a cutting tool of claim 1 wherein said chip-flow model incorporates a representation of a fracture mechanism describing a chip separation
 10 phenomenon.
 - 13. The method of designing a cutting tool of claim 12 wherein said chip-flow model incorporates a representation of a heat generating mechanism describing a thermal coupling phenomenon.

- 14. The method of designing a cutting tool of claim 3 wherein said chip-flow model incorporates a representation of a shear localization mechanism describing a shearing phenomenon.
- 20 15. The method of designing a cutting tool of claim 14 wherein said fracture mechanism defines a release of a chip from the workpiece and is represented by a debonding finite element in said chip-flow model.
- 16. The method of designing a cutting tool of claim 15 wherein said heat generating mechanism represents permanent deformation of said chip, fracture of said chip from said workpiece, and sliding of said chip with friction along a contact face of said cutting tool.
- 17. A method of designing a cutting tool of claim 16 further including the steps of:
 30 modeling said permanent deformation by representing in the chip-flow model
 that a first portion of heat generated by said deformation is introduced into said chip;
 modeling said fracture by representing in the chip-flow model that a second

portion of heat liberated by said debonding element upon release from said workpiece is introduced into said chip; and

modeling said chip sliding by representing in the chip-flow model that a third portion of heat generated by said sliding is introduced into said chip while a remaining portion of heat is introduced into said tool.

- 18. The method of designing a cutting tool of claim 17 wherein said shear localization mechanism represents a shear strain discontinuity in a region of said workpiece and is represented by shear discontinuity finite elements in said chip-flow model.
- 19. The method of spining a cutting tool of claim 18 further including the steps of: selecting said shall discontinuity finite elements to properly describe said shear localization mechanism;
- discretizing said discontinuity elements; and modifying material property-related parameters in said chip-flow model to be temperature-dependant.
 - 20. A system for designing a cutting tool comprising:

5

10

tool response model means for predicting tool response and including an input tool vector with at least one modifiable tool parameter;

chip-flow model means for predicting chip-flow and including a chip-flow input vector with at least one modifiable chip-flow parameter;

first executing means for executing said tool response model means to derive the prediction of said tool response;

second executing means for executing said chip-flow model means to derive the simulation of said chip-flow;

artificial intelligence means for evaluating said predicted tool response and said simulated chip-flow and for determining a correlation between said predicted tool response and said simulated chip-flow and acceptability criterion using an adaptive set of rules, wherein said artificial intelligence means includes means for providing recommendations based on said correlation and means for altering at least one of said

modifiable tool parameters, said modifiable chip-flow parameters, and said adaptive set of rules based on said recommendation; and

decision means for identifying an acceptable correlation corresponding to an optimum tool design and for repeating said prediction, said simulation, and said correlation with said recommendations if said acceptable correlation is not achieved.

5

10

15

- 21. The system for designing a cutting tool of claim 20 further including:
 database means for storing at least one of materials data, cutting operation data,
 past predicted tool responses, and past simulated chip-flows.
- 22. The system for designing a cutting tool of claim 20 wherein said tool response model means mathematically relates said input vector of tool parameters to an output vector of performance indices together constituting said predicted tool response; and wherein said chip-flow model means mathematically relates said input vector of chip-flow parameters to an output vector of performance indices together constituting said chip-flow simulation.
- 23. The system for designing a cutting tool of claim 20 wherein said second executing means performs an explicit time integration analysis.
- 24. The system for designing a cutting tool of claim 20 wherein said second executing means performs an implicit time integration analysis.
- 25. The system for designing a cutting tool of claim 20 further including:
 storing means for storing the predicted tool response of said tool response model means and the simulation of said chip-flow from said chip-flow model means in said data base.
- 26. The system for designing a cutting tool of claim 20 further including interactive viewing means for interactively viewing an animated rendering of said cutting operation and concurrently monitoring performance indices of said predicted tool response and said chip-flow simulation.

- 27. The system for designing a cutting tool of claim 20 wherein said chip-flow model means incorporates fracture mechanism means for representing a fracture mechanism describing a chip separation phenomenon.
- 5 28. The system for designing a cutting tool of claim 27 wherein said chip-flow model means incorporates heat generating means for representing a heat generating mechanism describing a thermal coupling phenomenon.
- The system for designing a cutting tool of claim 27 wherein said chip-flow
 model means incorporates shear localization means for representing a shear localization mechanism describing a shearing phenomenon.
- 30. The system for designing a cutting tool of claim 29 wherein said fracture mechanism means defines a release of a chip from the workpiece and is represented by a debonding finite element in said chip-flow model means.
 - 31. The system for designing a cutting tool of claim 30 wherein said heat generating means represents permanent deformation of said chip, fracture of said chip from said workpiece, and sliding of said chip with friction along a contact face of said cutting tool.
 - 32. The system for designing a cutting tool of claim 31 further including:

20

25

deformation modeling means for modeling said permanent deformation by representing in the chip-flow model means that a first portion of heat generated by said permanent deformation is introduced into a deforming chip;

fracture modeling means for modeling said fracture by representing in the chip-flow model means that a second portion of heat generated by said debonding element upon release from said workpiece is introduced into said chip; and

chip sliding modeling means for modeling said chip sliding by representing in the chip-flow model means that a third portion of heat generated by said chip sliding is introduced into said chip while a remaining portion is introduced into said tool.

- 33. The system for designing a cutting tool of claim 29 wherein said shear localization means represents a shear strain discontinuity in a region of said workpiece and is represented by shear discontinuity finite elements in said chip-flow model means.
- 5 34. The system for designing a cutting tool of claim 33 further including: selecting means for selecting said shear discontinuity finite elements to properly describe said shear localization mechanism;

discretizing means for discretizing said discontinuity elements; and modifying means for modifying material property-related parameters in said chip-flow model means to be temperature-dependant.

- 35. A method of designing a cutting tool substantially as hereinbefore described with reference to the accompanying drawings.
- 15 36. A system for designing a cutting tool substantially as hereinbefore described with reference to the accompanying drawings.

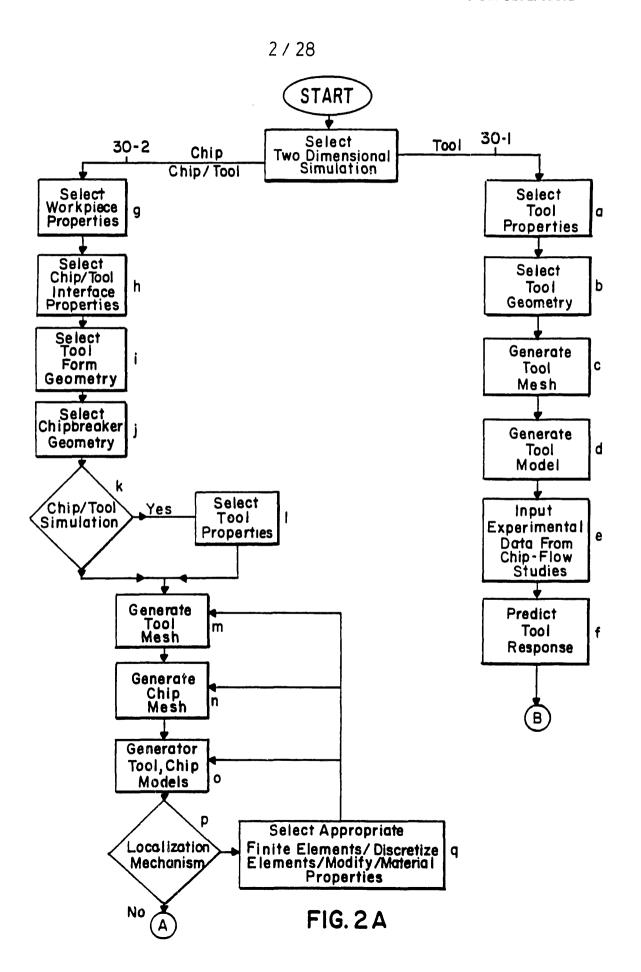
20

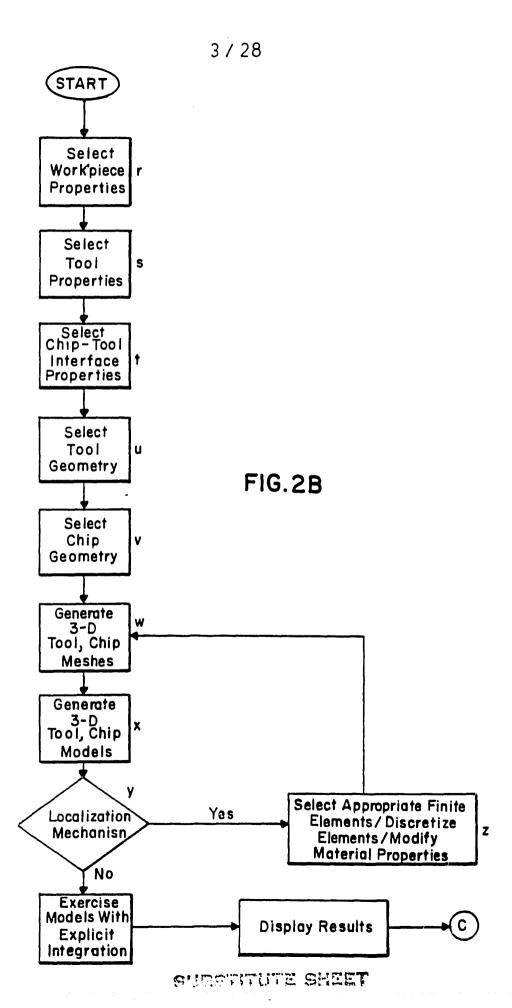
DATED this 16th day of November, 1994

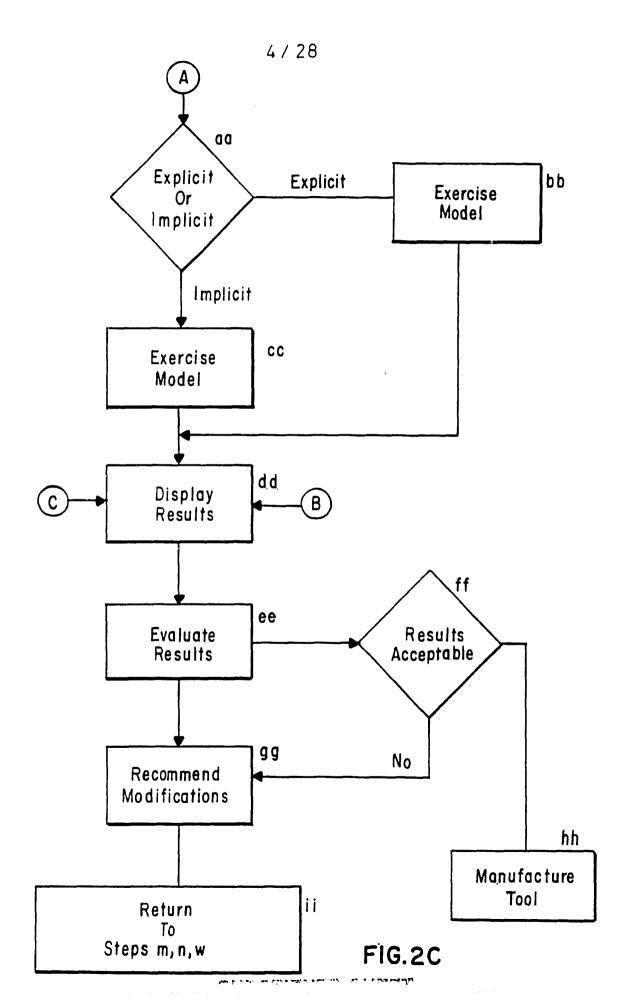
VALENITE, INC.

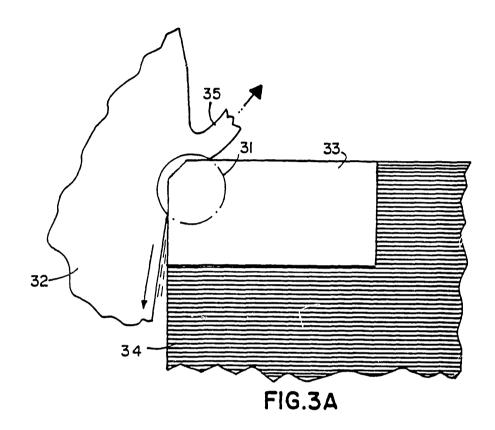
By its Patent Attorneys

25 DAVIES COLLISON CAVE









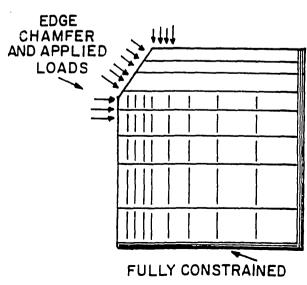
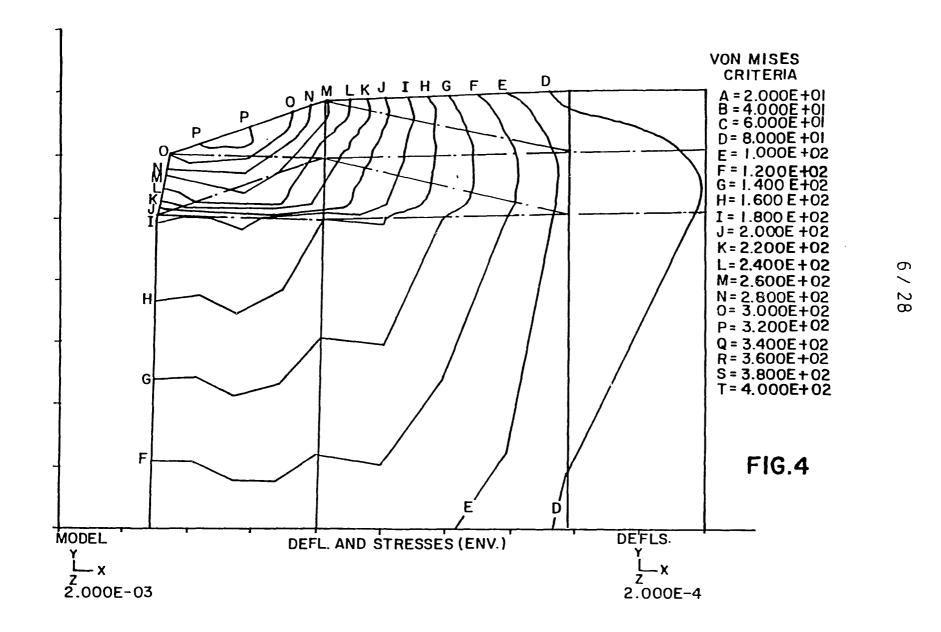
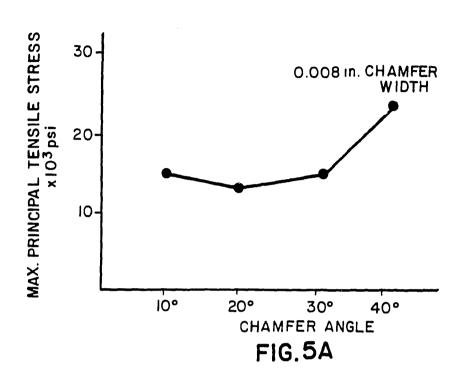
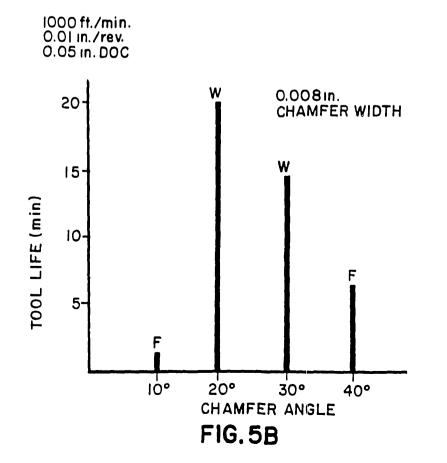


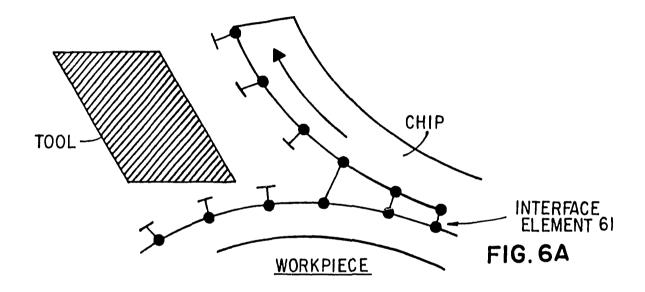
FIG.3B

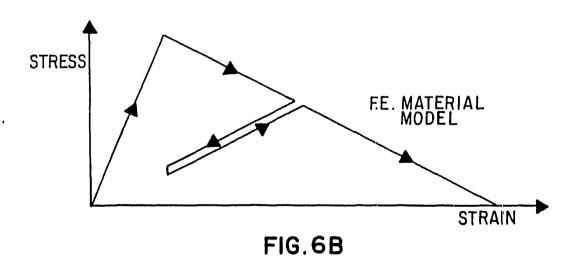
CONTENTE CHEET

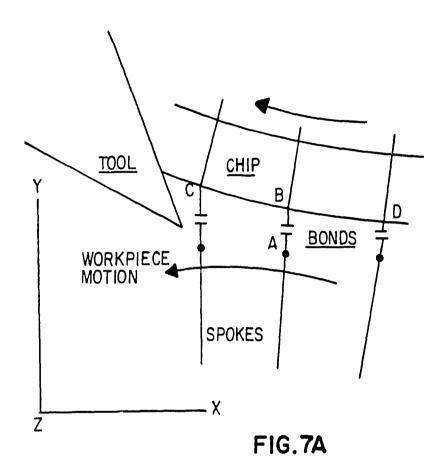












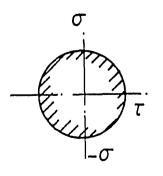


FIG. 7B

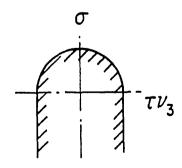


FIG. 7C

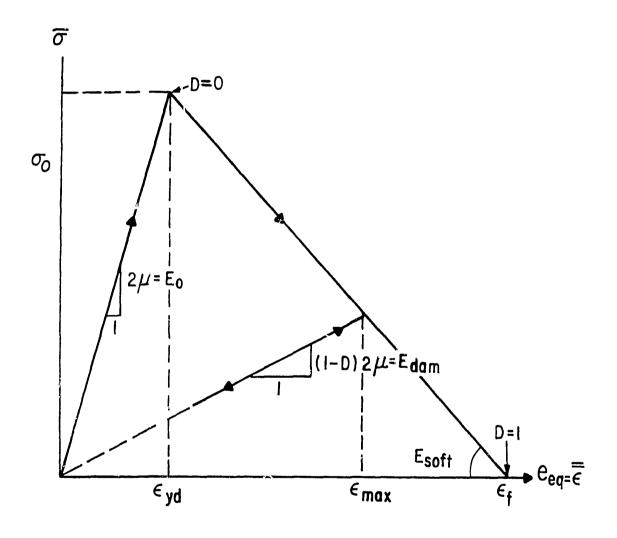


FIG.8

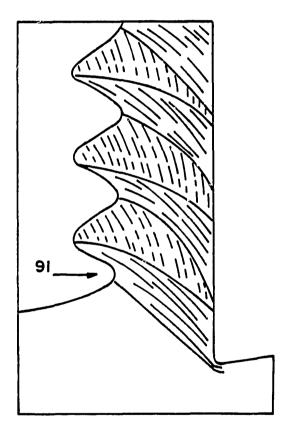


FIG.9

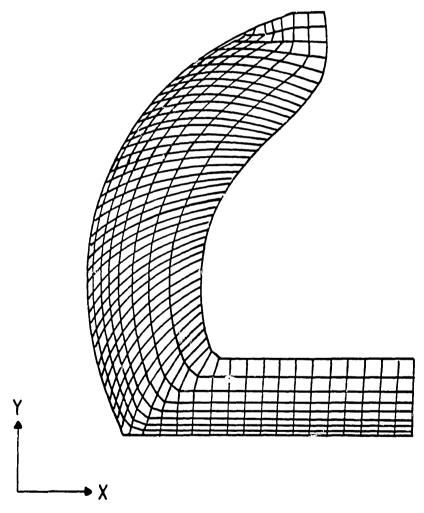


FIG. IOA

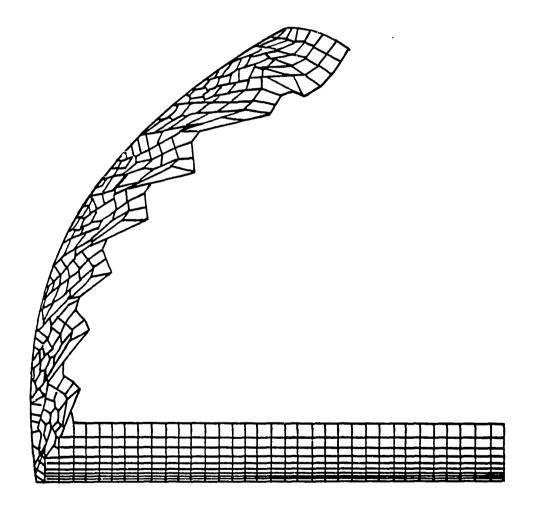
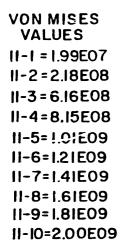
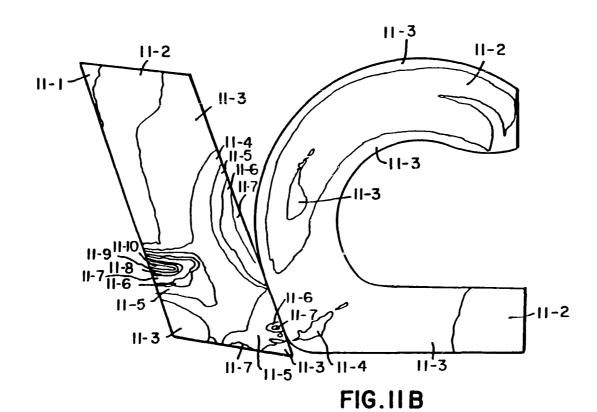
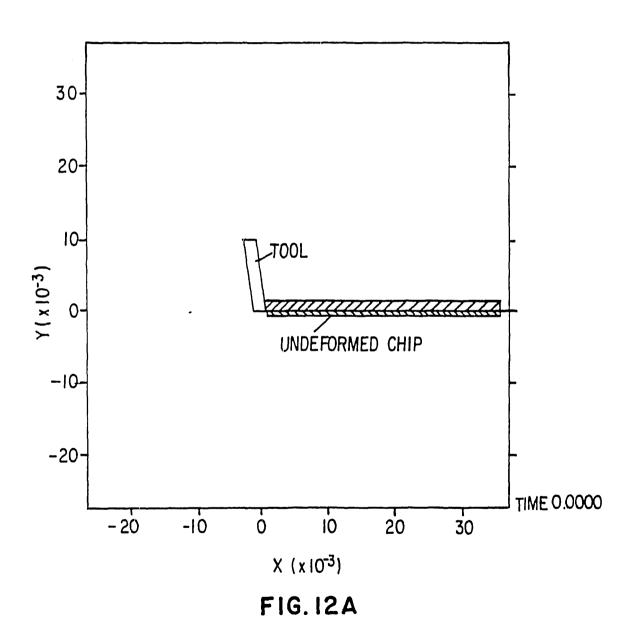
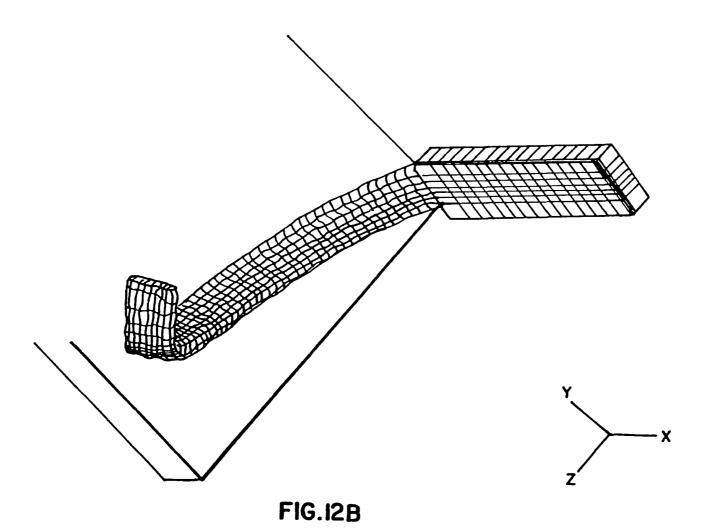


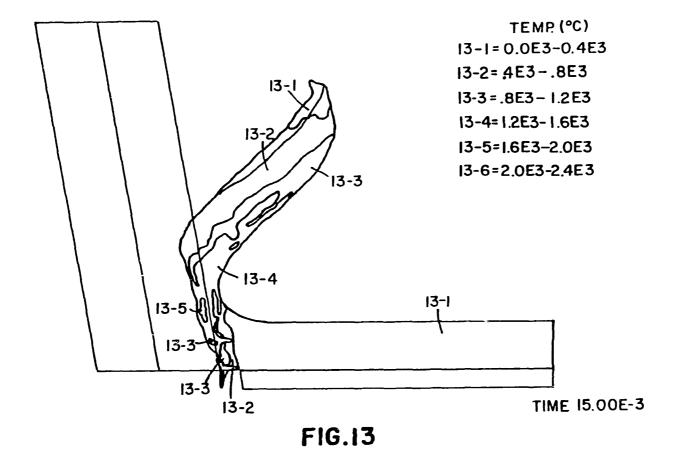
FIG. IOB











Printer and the bring

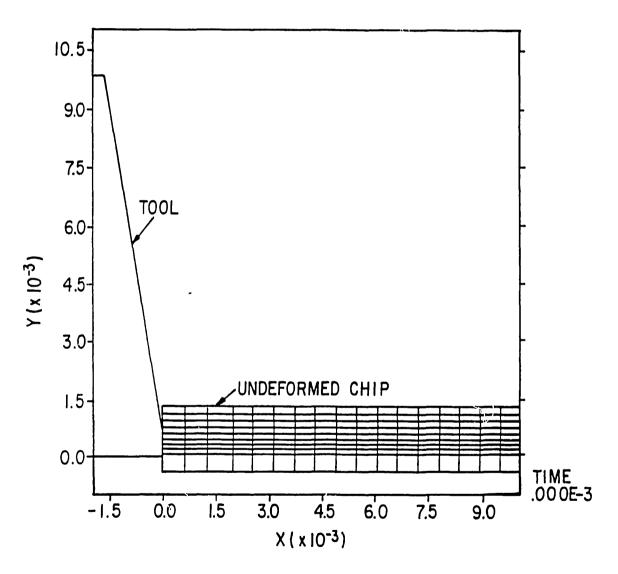
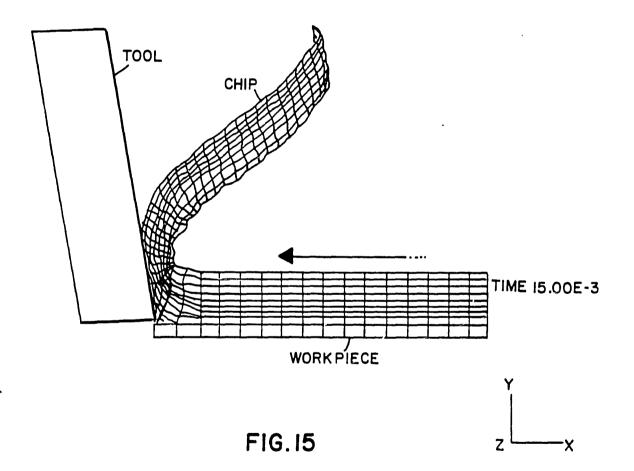


FIG. 14



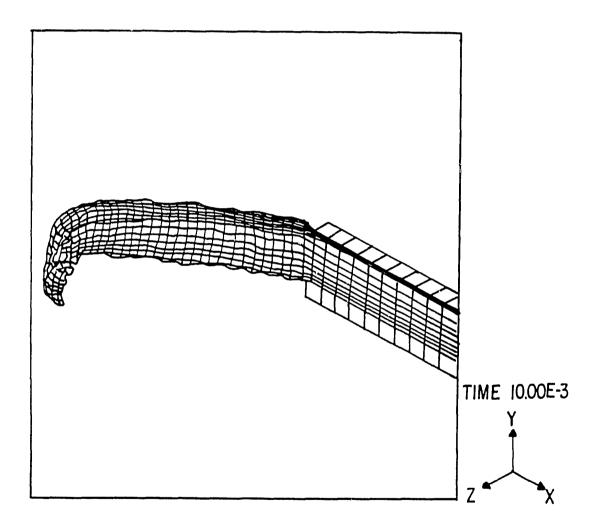
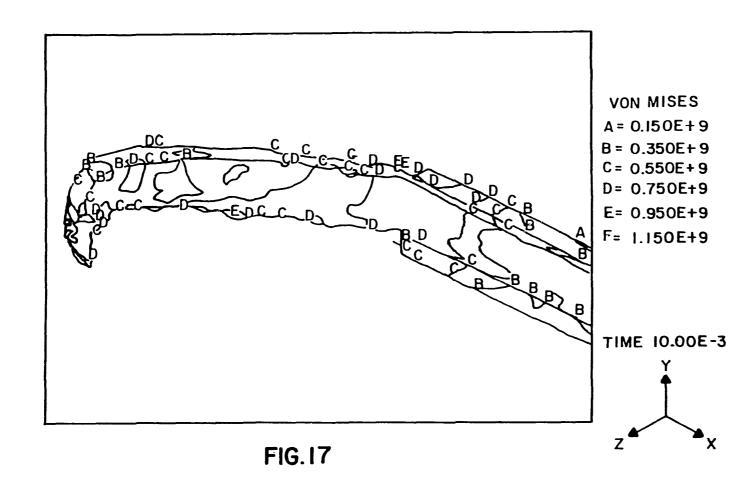
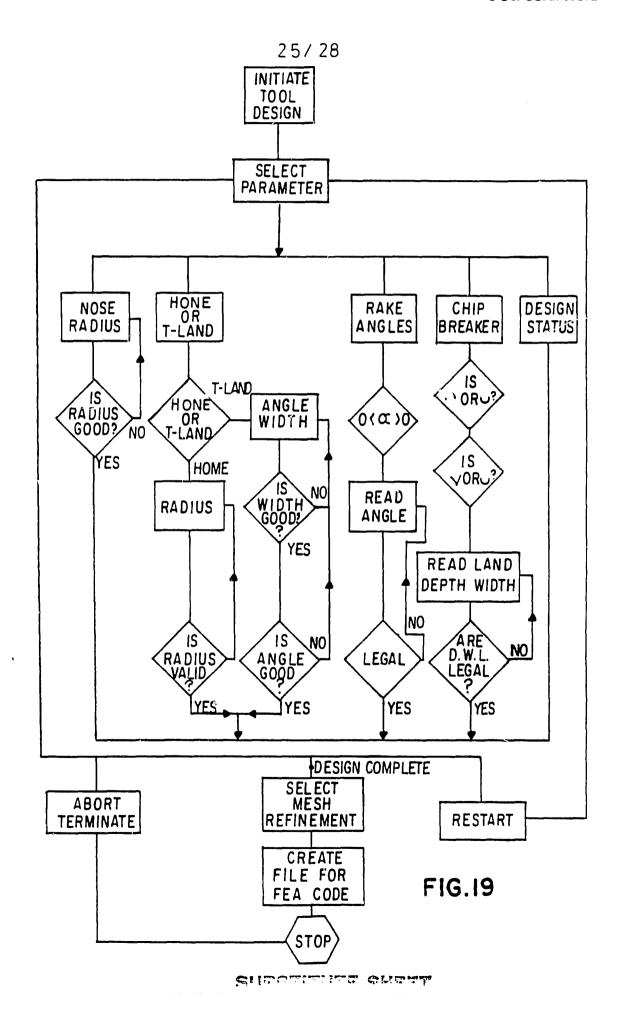


FIG. 16





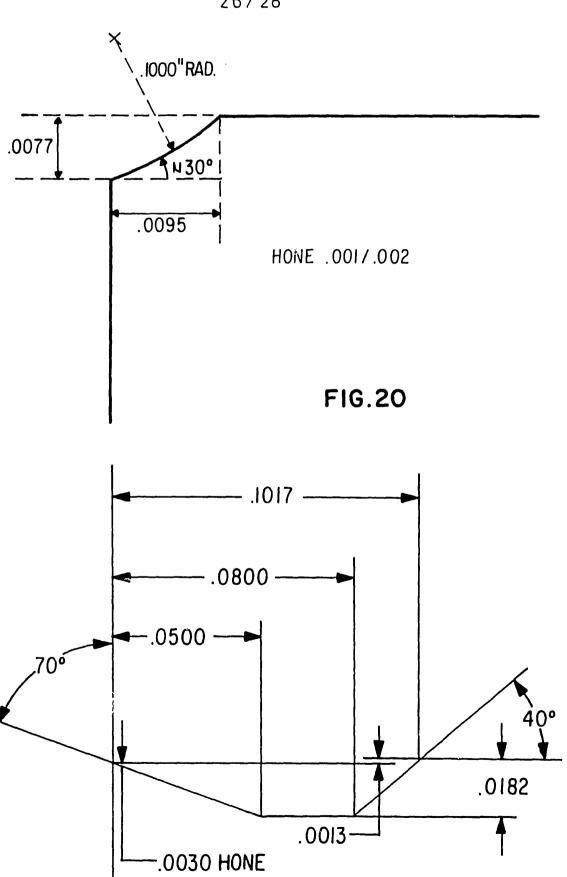


FIG. 21

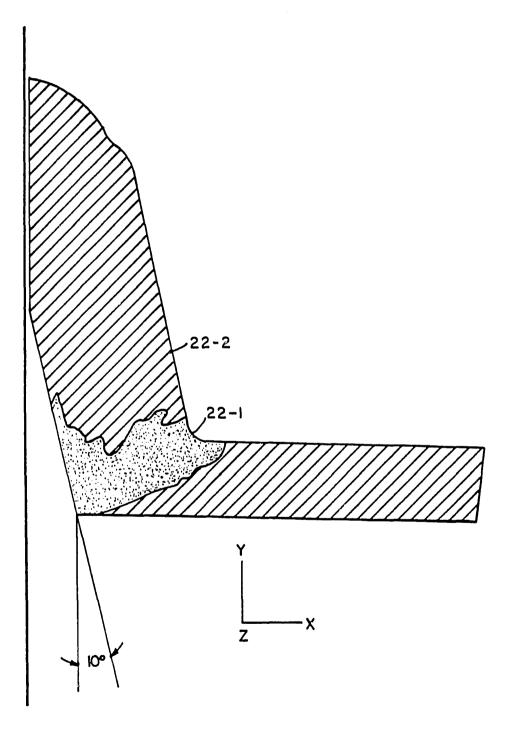


FIG.22

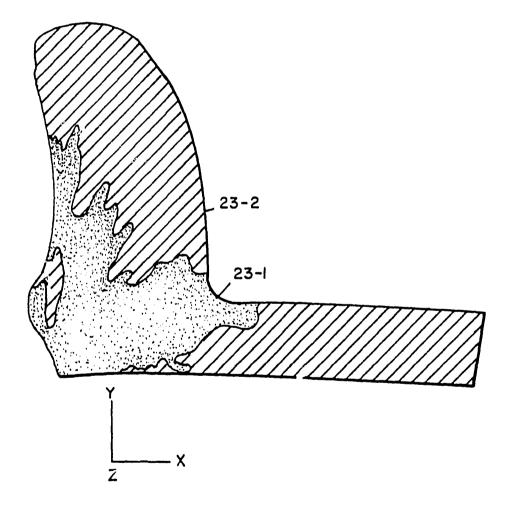


FIG. 23

INTERNATIONAL SEARCH REPORT

International Application No

PCT/US 92/05172

		CT MATTER (if several classification Classification (IPC) or to both National		
•	5 G05B19/40			
II. FIELDS S	EARCHED			
		Minimum Docu	mentation Searched?	
Classification	System		Classification Symbols	
Int.Cl. 5		G05B		
			er than Minimum Documentation ts are included in the Fields Searched ⁸	
		D TO BE RELEVANT 9		
Category °	Citation of De	ocument, 11 with indication, where appro	priate, of the relevant passages 14	Relevant to Claim No.13
A	SOVIET ENGINEERING RESEARCH. (STANKI I INSTRUMENTY & VESTNIK MASHINOSTROENIA MASHINOSTROCNIE) vol. 8, no. 8, 1988, NEW YORK US pages 112 - 118 V.A. GRECHISHNIKOV 'Integrated CAD Systems for Designing Cutting Tools and Machine Parts' see page 112 - page 118			1,13,25, 29,40, 52,55
A	INSTRUM MASHINO vol. 8, pages 1 KIRSANO Flexibl	ENGINEERING RESEARCH. ENTY & VESTNIK MASHING STROCNIE) no. 8, 1988, NEW YORM 09 - 111 V G.N. 'Tooling Manage e Manufacture' e 110 - page 111	DSTROENIA K US	1,13,25, 39,40, 52,55
"Special categories of cited documents: 10 "A" document defining the general state of the art which is not considered to be of particular relevance "E" earlier document but published on or after the international filing date "I" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified) "O" document referring to an oral disclosure, use, exhibition or other means "P" document published prior to the international filing date but later than the priority date claimed			"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step "Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art. "A" document member of the same patent family	
IV. CERTIF	TCATION			
Date of the A	•	the International Search BER 1992	Date of Mailing of this International Se	arch Report
International	Searching Authority		Signature of Authorized Officer	
EUROPEAN PATENT OFFICE			HAUSER L.E.R.	

PCT/US 92/05172

International Application No

III. DOCUME	International Application No DOCUMENTS CONSIDERED TO BE RELEVANT (CONTINUED FROM THE SECOND SHEET)				
Category o					
	MACHINE DESIGN vol. 62, no. 21, October 1990, CLEVELAND, OHIO, USA pages 23 - 44 'Design, Modeling and Analysis' see pages 23, 24, 26, 28, 30, 32, 34, 38, 39, 40, 42, 44	1,13,25, 39,40, 52,55			
	39, 40, 42, 44				
	O (azzira shoet) (January 1985)				